Dell PowerEdge R960

Technical Guide

Regulatory Model: E84S Regulatory Type: E84S001 October 2023 Rev. A02



Notes, cautions, and warnings

(i) NOTE: A NOTE indicates important information that helps you make better use of your product.

CAUTION: A CAUTION indicates either potential damage to hardware or loss of data and tells you how to avoid the problem.

MARNING: A WARNING indicates a potential for property damage, personal injury, or death.

© 2023 Dell Inc. or its subsidiaries. All rights reserved. Dell Technologies, Dell, and other trademarks are trademarks of Dell Inc. or its subsidiaries. Other trademarks may be trademarks of their respective owners.

Contents

Chapter 1: System overview	5
Key workloads	
New technologies	5
Chapter 2: System features and generational comparison	7
Chapter 3: Chassis views and features	10
Front view of the system	
Rear view of the system	
Inside the system	
Quick Resource Locator	14
Chapter 4: Processor	
Processor features	
Supported processors	15
Chapter 5: Memory subsystem	16
Supported memory	
Chapter 6: Storage	17
Storage controllers	
Supported Drives	17
Internal storage configuration	
External Storage	
Chapter 7: Networking	19
Overview	
OCP 3.0 support	
Supported OCP cards	
OCP NIC 3.0 vs. rack Network Daughter Card comparisons	
Chapter 8: PCle subsystem	21
PCIe risers	21
Chapter 9: Power, thermal, and acoustics	
Power	
Power Supply Units	
Thermal	
Thermal design	
Acoustics	
Acoustical configurations of R960	
PowerEdge acoustical specifications	

Chapter 10: Rack, rails, and cable management	
Rails and cable management information	
Chapter 11: Operating Systems and Virtualization	51
Supported Operating Systems	51
Chapter 12: Dell OpenManage Systems Management	52
Integrated Dell Remote Access Controller (iDRAC)	
Systems Management software support matrix	
Chapter 13: Appendix D: Services	55
Default service levels	
ProDeploy Infrastructure Suite	55
Supplemental Deployment Services	
Unique Deployment Scenarios	
DAY 2 - Automation Services with Ansible	60
ProSupport Infrastructure Suite	
Specialty Support Services	61
Consulting Services	
Resources	
Chapter 14: Appendix A: Additional specifications	
Chassis dimension	
Chassis weight	
NIC port specifications	
Video specifications	
USB Ports	
PSU rating	
Environmental specifications	
Thermal restriction matrix	71
Thermal air restrictions	
Chapter 15: Appendix B. Standards compliance	
Chapter 16: Appendix C Additional resources	75

System overview

The Dell PowerEdge R960 is Dell's latest four-socket, rack server that is designed to run complex workloads using highly scalable memory, I/O, and network options.

The system features:

- Up to 4 x 4th Gen Intel® Xeon® Scalable Processors with up to 60 cores
- 64 DDR5 DIMM slots, supports maximum 16 TB
- Four AC or DC power supply units with 2+2 redundancy
- Up to 8 x 2.5-inch SAS/SATA (HDD/SSD) drives
- Up to 16 x 2.5-inch SAS/SATA (HDD/SSD) drives
- Up to 32 x 2.5-inch SAS/SATA (HDD/SSD) drives
- Up to 24 x 2.5-inch NVMe (SSD) drives
- Up to 16 x 2.5-inch SAS/SATA (HDD/SSD) + 8 x 2.5-inch NVMe (SSD) drives
- Up to 16 x EDSFF E3.S Gen5 NVMe (SSD) drives
- Up to 16 x EDSFF E3.S Gen5 NVMe (SSD) + 8 x 2.5-inch SAS/SATA (HDD/SSD) drives
- PCI Express® (PCIe) 5.0 enabled expansion slots
- Network interface technologies to cover Network Interface Card (NIC)
- () NOTE: For more information about how to hot swap NVMe PCIe SSD U.2 device, see the *Dell Express Flash NVMe PCIe SSD User's Guide* at https://www.dell.com/support > Browse all products > Infrastructure > Data Center Infrastructure > Storage Adapters & Controllers > Dell PowerEdge Express Flash NVMe PCIe SSD > Select This Product > Documentation > Manuals and Documents.

(i) NOTE: All instances of SAS, SATA, NVMe drives are referred to as drives in this document, unless specified otherwise.

CAUTION: Do not install GPUs, network cards, or other PCIe devices on your system that are not validated and tested by Dell. Damage caused by unauthorized and invalidated hardware installation will null and void the system warranty.

Topics:

- Key workloads
- New technologies

Key workloads

Customers looking for accelerated compute to maximize performance in a dense, scalable server architecture to address the following applications:

- SAP/HANA, Oracle, SQL
- Database, ERP, CRM, batch
- Data warehouse, business intelligence
- Virtualization/VM and VDI
- AI, HPC and ML/DL

New technologies

Table 1. New technologies

Technology	Detailed Description
4 th Gen Intel® Xeon® Scalable Processors	Core count: Up to 60 core processor

Table 1. New technologies (continued)

Technology	Detailed Description
	UPI speed: Up to 4 links per CPU, speed: 12.8 GT/s, 14.4 GT/s, 16 GT/s
	Maximum number of PCIe lanes per CPU: Integrated 80 PCIe 5.0 lanes @ 32GT/s PCIe Gen5
	Maximum TDP: 350 W
4800 MT/s DDR5 Memory	Max 16 DIMM per processor and 64 DIMMs per system
	Supports DDR5 ECC RDIMM
PCIe Gen	Gen5 @32 GT/s
PCIe Slot	Up to twelve Gen5 (x16) slots
Flex I/O	LOM board, 2x1Gb with BCM5720 LAN controller (optional)
	 Rear I/O with: 1x Dedicated iDRAC Ethernet port 1 x USB 3.0 1 x USB 2.0 1 x VGA port
	Serial Port (Optional) with STD RIO board
	OCP Mezz 3.0 (supported by x16 PCIe lanes) (optional)
	 Front I/O with: 1 x USB 2.0 1x iDRAC Direct (Micro-AB USB) port 1 x VGA port
CPLD 1-wire	Support payload data of Front PERC, Riser, BP and Rear IO to BOSS-N1 and iDRAC
Dedicated PERC	PERC 11: • H755, H355, HBA355i PERC 12: • H965i, H965e
Software RAID	OS RAID / S160
Power Supplies	60 mm dimension is the new PSU form factor on 15G design
	Titanium 1100 W AC/HVDC
	Platinum 1400 W AC/HVDC
	Titanium 1800 W AC/HVDC
	86 mm dimension PSU
	Platinum 2400 W AC/HVDC
	Titanium 2800 W AC/HVDC

2

System features and generational comparison

The following table shows the comparison between the PowerEdge R960 with the PowerEdge R940xa.

Table 2. Features comparison

Features	PowerEdge R960	PowerEdge R940xa		
Processors	4 x 4 th Gen Intel® Xeon® Scalable Processors	4 x 2 nd Generation Intel® Xeon® Scalable Processor		
CPU interconnect	Intel Ultra Path Interconnect (UPI)	Intel Ultra Path Interconnect (UPI)		
Memory	 64 x DDR5 RDIMM Up to 4800 MT/s (1 DPC) / 4400 MT/s (2 DPC) 	 48 x DDR4 RDIMM, LRDIMM 24 x PMem (Intel Optane Persistent Memory 12 x NVDIMM 		
Storage Controllers	 PERC 11G: H755, H355 PERC 12G: H965i, H965e HBA 11: HBA355i, HBA355e BOSS-N1 Software RAID: S160 	 PERC 9G: H330, H730p PERC 10G: H740p, H840 HBA 9: HBA330, 12 Gbps SAS HBA HBA 11: HBA355e BOSS adapter Software RAID: S140 Internal Dual SD Module 		
Drive Bays	 Front bays: 2.5 inches - 24Gb SAS, 6Gb SATA, Gen3/4 NVMe E3.S - NVMe Gen5 EDSFF 	Front bays: • 2.5 inches - 12Gb SAS, 6Gb SATA, Gen3 NVMe		
Power Supplies	 AC (Platinum): 1400 W, 2400 W AC (Titanium): 1100 W, 1800 W, 2800 W 	 AC (Platinum): 750 W, 1100 W, 1600 W, 2000 W AC (Titanium): 1600 W, 2600 W LVDC @-48VDC Input: 1100 W 		
Cooling Options	Air Cooling	Air Cooling		
Fans Standard (STD) fans		Standard (STD) fans		
	Up to 6 sets (dual fan module) hot plug fans	Up to six hot swap fans		
Dimension	Height: 174.3 mm (6.86 inches)	Height: 174.3 mm (6.86 inches)		
	Width: 482 mm (18.97 inches)	Width: 441.16 mm (17.37-inches)		
	Depth: 883.195 mm (34.77 inches) with bezel	Depth: 877.84 mm (34.56 inches) with bezel		
	869.195 mm (34.22 inches) without bezel	865.9 (34.09-inches) without bezel		
Form Factor	4U rack server	4U rack server		
Embedded Management	 iDRAC9 iDRAC Direct iDRAC RESTful with Redfish iDRAC Service Manual Quick Sync 2 wireless module 	 iDRAC9 iDRAC Direct Quick Sync 2 BLE/wireless module 		
Bezel	Optional LCD bezel or security bezel	Optional LCD bezel or security bezel		

Table 2. Features comparison (continued)

Features	PowerEdge R960	PowerEdge R940xa			
OpenManage Software	 CloudIQ for PowerEdge plug in OpenManage Enterprise OpenManage Enterprise Integration for VMware vCenter OpenManage Integration for Microsoft System Center OpenManage Integration with Windows Admin Center OpenManage Power Manager plugin OpenManage Service plugin OpenManage Update Manager plugin 	 OpenManage Enterprise OpenManage Power Center 			
Mobility	OpenManage Mobile	OpenManage Mobile			
Integrations and Connections	 OpenManage Integrations BMC TrueSight Microsoft System Center OpenManage Integration with ServiceNow Red Hat Ansible Modules Terraform Providers VMware vCenter and vRealize Operations Manager 	 OpenManage Integrations BMC TrueSight Microsoft System Center Red Hat Ansible Modules VMware vCenter IBM Tivoli Netcool/ OMNIbus Micro Focus Operations Manager I Nagios Core Nagios XI 			
Security	 Cryptographically signed firmware Secure Boot Secure Erase Silicon Root of Trust System Lockdown (requires iDRAC9 Enterprise or Datacenter) TPM 2.0 FIPS, CC-TCG certified, TPM 2.0 China NationZ Secured Component Verification (Hardware integrity check) Data at Rest Encryption (SEDs with local or external key mgmt) 	 Cryptographically signed firmware Secure Boot Secure Erase Silicon Root of Trust System Lockdown (requires iDRAC9 Enterprise or Datacenter) TPM 1.2/2.0 FIPS, CC-TCG certified, TPM 2.0 China NationZ 			
Embedded NIC	2 x 1 GbE LOM (optional)	4 x 1 GbE Network Daughter Card (optional)			
Networking Options	OCP x16 (optional) Mezz 3.0 (i) NOTE: The system allows either LOM card or an OCP card or both to be installed in the system.	NA			
GPU Options	Up to four double wide 400 W	Up to two double wide 300 W, or eight single wide 75 W accelerators			
Ports	Front PortsRear Ports• 1 x USB 2.0• 1 x USB 2.0• 1 x VGA• 1 x USB 2.0• 1 x iDRAC Direct (Micro-AB USB) port• 1 x USB 2.0• 1 x USAC Direct (Micro-AB USB) port• 1 x USB 3.0• 1 x USB 3.0• 1 x Serial port (optional)• 1 x VGA	 Front Ports 1 x Dedicated iDRAC micro-USB 2 x USB 2.0 1 x VGA Rear Ports 2 x USB 3.0 1 x Dedicated iDRAC Ethernet port 1 x Serial port 1 x VGA 			
	Internal Port: 1 x USB 3.0 (optional)	Internal Port: 1 x USB 3.0 (optional)			
PCle	Up to 12 x PCle Gen5 slots	Up to 12 x Gen3 slots, (6x16 slots or 2x16 + 10x8 slots)			

Table 2. Features comparison (continued)

Features	PowerEdge R960	PowerEdge R940xa
Operating System and Hypervisors	 Canonical Ubuntu Server LTS Microsoft Windows Server with Hyper-V Red Hat Enterprise Linux SUSE Linux Enterprise Server VMware ESXi For specifications and interoperability details, see Dell Enterprise Operating Systems on Servers, Storage, and Networking page at Dell.com/OSsupport. 	 Canonical Ubuntu Server LTS Citrix Hypervisor Windows Server LTSC with Hyper-V Red Hat Enterprise Linux SUSE Linux Enterprise Server VMware ESXi For specifications and interoperability details, see Dell Enterprise Operating Systems on Servers, Storage, and Networking page at Dell.com/ OSsupport.

(i) NOTE: OpenManage will be offered for R960 in future release.

Chassis views and features

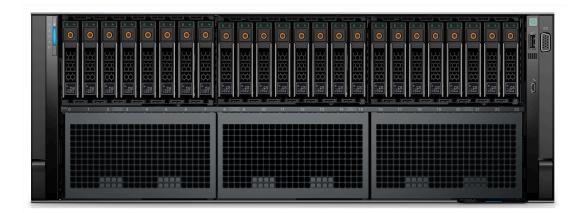
Topics:

- Front view of the system
- Rear view of the system
- Inside the system
- Quick Resource Locator

Front view of the system



Figure 1. Front view of 32 x 2.5-inch drive system





	00	. <u> </u>

Figure 3. Front view of 16 x 2.5-inch drive system

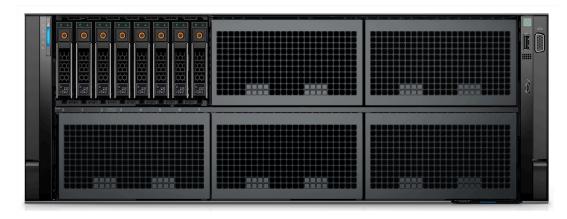


Figure 4. Front view of 8 x 2.5-inch drive system

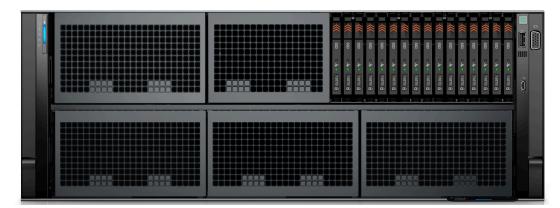


Figure 5. Front view of 16 x EDSFF E3.S Gen5 NVMe drive system



Figure 6. Front view of 16 x EDSFF E3.S Gen5 NVMe with 8 x 2.5-inch drive system

Rear view of the system

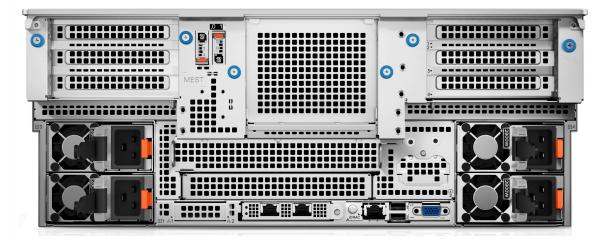


Figure 7. Rear view of the system with basic configuration

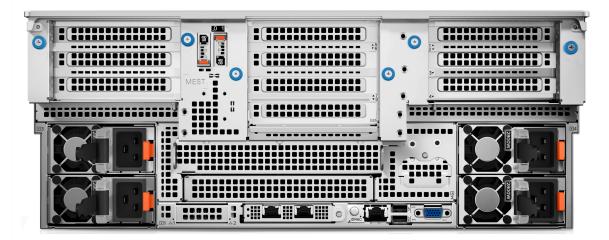


Figure 8. Rear view of the system with scale out configuration

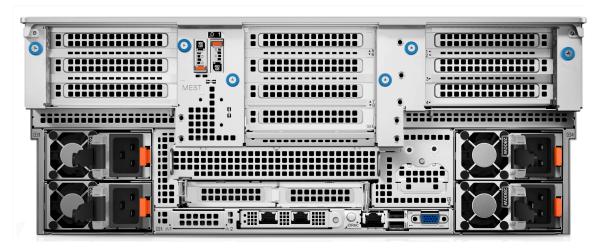


Figure 9. Rear view of the system with maximum I/O configuration

Inside the system

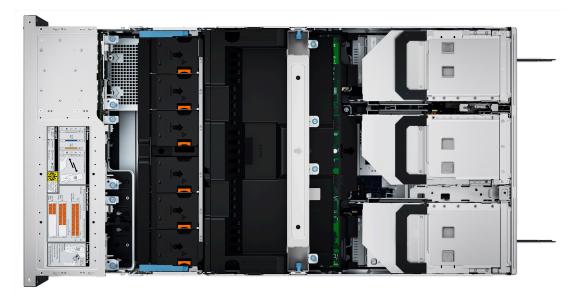


Figure 10. Inside the system

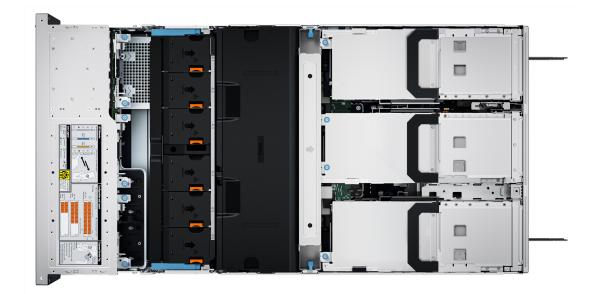


Figure 11. Inside the system with full length risers and GPU shroud

Quick Resource Locator

The QRL on everything (SILs, GSG, Owner's Manual except on the EST) is a generic QRL for R960 that leads to a webpage for that product. That webpage has links for things like setup and service videos, iDRAC manual, and other things that apply to the platform. The QRL on the EST is unique and specific to that service tag and will contain the Service Tag number and the iDRAC password. The label and the QRL code within it are printed on demand at the L10 factories. This QRL links to a webpage that shows the exact configuration as built for that customer, and the specific warranty purchased. It is one click away from the same content of generic information that applies to R960 that is available in the other QRLs.



Quick Resource Locator Dell.com/QRL/Server/PER960

Figure 12. Quick Resource Locator for PowerEdge R960 system

Processor

Topics:

• Processor features

Processor features

The 4th Generation Intel[®] Xeon[®] Processors stack is the next generation data center processor offering with significant performance increases, integrated acceleration, and next generation memory and I/O. Sapphire Rapids accelerate customer usages with unique workload optimizations.

The following lists the features and functions that are in the upcoming 4th Generation Intel[®] Xeon[®] Scalable Processor offering:

- Faster UPI with up to four Intel Ultra Path Interconnect (Intel UPI) at up to 16 GT/s, increasing multisocket bandwidth
- More, faster I/O with PCI Express 5 and up to 80 lanes (per socket)
- Enhanced Memory Performance with DDR5 support and memory speed up to 4800 MT/s in one DIMM per channel (1DPC) and 4400 MT/s in two DIMM per channel (2DPC)
- New built-in accelerators for data analytics, networking, storage, crypto, and data compression

Supported processors

The following table shows the Intel Sapphire Rapids SKUs that are supported on the R960.

Proces sor	Clock Speed (GHz)	Cache (M)	UPI (GT/s)	Cores	Threads	Turbo	Memory Speed (MT/s)	Memory Capacity	TDP
8490H	1.9	113	16	60	120	Turbo	4800	6 TB	350 W
8468H	2.1	105	16	48	96	Turbo	4800	6 TB	330 W
8460H	2.2	105	16	40	80	Turbo	4800	6 TB	330 W
8454H	2.1	83	16	32	64	Turbo	4800	6 TB	270 W
8450H	2	75	16	28	56	Turbo	4800	6 TB	250 W
8444H	2.9	45	16	16	32	Turbo	4800	6 TB	270 W
6448H	2.4	60	16	32	64	Turbo	4800	6 TB	250 W
6434H	3.7	23	16	8	16	Turbo	4800	6 TB	195 W
6418H	2.1	60	16	24	48	Turbo	4800	6 TB	185 W
6416H	2.2	45	16	18	36	Turbo	4800	6 TB	165 W

Table 3. Supported Processors for R960

(i) NOTE: Mixing of the processors in a 4S configurations is not recommended.

Memory subsystem

The PowerEdge XR8610t and XR8620t supports up to 8 DIMMs, with up to 512 GB of standard memory and speeds of up to 4800 MT/s.

Topics:

• Supported memory

Supported memory

Table 4. Memory technology comparison

Feature	PowerEdge R960 (DDR5)
DIMM type	RDIMM
Transfer speed	4800 MT/s (1DPC), 4400 MT/s (2DPC)
Voltage	1.1 V

Table 5. Supported memory matrix

DIMM type	Rank	Capacity	DIMM rated	Operating Speed		
			voltage and speed	1 DIMM per channel (DPC)	2 DIMMs per channel (DPC)	
RDIMM	1 R	16 GB	DDR5 (1.1 V), 4800 MT/s	4800 MT/s	4400 MT/s	
	2 R	32 GB, 64 GB	DDR5 (1.1 V), 4800 MT/s	4800 MT/s	4400 MT/s	
	4 R	128 GB	DDR5 (1.1 V), 4800 MT/s	4800 MT/s	4400 MT/s	
	8 R	256 GB	DDR5 (1.1 V), 4800 MT/s	4800 MT/s	4400 MT/s	

(i) **NOTE:** The processor may reduce the performance of the rated DIMM speed.

Storage

Topics:

- Storage controllers
- Supported Drives
- Internal storage configuration
- External Storage

Storage controllers

Dell RAID controller options offer performance improvements, including the fPERC solution. fPERC provides a base RAID HW controller without consuming a PCIe slot by using a small form factor and high-density connector to the base planar.

16G PERC Controller offerings are a heavy leverage of the 15G PERC family. The Value and Value Performance levels carry over to 16G from 15G. New to 16G is the Avenger-based Premium Performance tier offering. This high-end offering drives IOPs performance and enhanced SSD performance.

Table 6. PERC Series controller offerings

Performance Level	Controller and Description
Entry	S160
Value	H355, HBA355 (internal/external)
Value Performance	H755
Premium Performance	Н965і, Н965е

(i) NOTE: PowerEdge does not support Tri-Mode, the mixing of SAS, SATA, and NVMe behind the same controller.

() NOTE: For more information about the features of the Dell PowerEdge RAID controllers (PERC), Software RAID controllers, or BOSS card, and on deploying the cards, see the storage controller documentation at www.dell.com/storagecontrollermanuals.

(i) NOTE: From December 2021, H355 replaces H345 as the entry raid controller. H345 is deprecated in January 2022.

Supported Drives

The table shown below lists the internal drives supported by the R960.

Table 7. Supported Drives

Form Factor	Туре	Speed	Rotational Speed	Capacities
2.5 inches	vSAS	12 Gb	SSD	1.92 TB, 3.84 TB, 960 GB, 7.62 TB
2.5 inches	SAS	24 Gb	SSD	1.92 TB, 1.6 TB, 800 GB, 3.84 TB, 960 GB, 7.68 TB
2.5 inches	SATA	6 Gb	SSD	1.92 TB, 480 GB, 960 GB, 3.84 TB
2.5 inches	NVMe	Gen4	SSD	1.6 TB, 3.2 TB, 6.4 TB, 1.92 TB, 3.84 TB, 15.63 TB, 7.68 TB, 800 GB, 400 GB

Table 7. Supported Drives (continued)

Form Factor	Туре	Speed	Rotational Speed	Capacities
2.5 inches	DC NVMe	Gen4	SSD	3.84 TB, 960 GB
2.5 inches	SAS	12 Gb	10 K	600 GB, 1.2 TB, 2.4 TB
EDSFF E3.S	NVMe	Gen5	SSD	3.84 ТВ, 7.68 ТВ

Internal storage configuration

R960 available internal storage configurations:

- 8 x 2.5" (SAS/SATA) Smartflow
- 16 x 2.5" (SAS4/SATA) Smartflow
- 16 x 2.5"(SAS4/SATA) + 8 x 2.5" NVMe
- 32 x 2.5" (SAS4/SATA) Dual Controller
- 24 x 2.5" (NVMe Gen4) Passive
- 16 x EDSFF E3.S (NVMe Gen5)
- 16 x EDSFF E3.S (NVMe Gen5) + 8 x 2.5" (SAS4/SATA)

NOTE: The Universal Backplane supports HW RAID for SAS/SATA with direct attach NVMe, and does not support HW RAID for NVMe.

External Storage

The R960 support the external storage device types listed in the table below.

Table 8. Support External Storage Devices

Device Type	Description				
External Tape	Supports connection to external USB tape products				
NAS/IDM appliance software	Supports NAS software stack				
JBOD	Supports connection to 12 Gb MD-series JBODs				

Networking

Ź

Topics:

- Overview
- OCP 3.0 support

Overview

PowerEdge offers a wide variety of options to get information moving to and from our servers. Industry best technologies are chosen, and systems management features are added by our partners to firmware to tie in with iDRAC. These adapters are rigorously validated for worry-free, fully supported use in Dell servers.

OCP 3.0 support

Table 9. OCP 3.0 feature list

Feature	OCP 3.0
Form factor	SFF
PCle Gen	Gen4
Max PCle width	x16
Max no. of ports	4
Port type	BT/SFP/SFP+/SFP28/SFP56/Q56
Max port speed	100 GbE
NC-SI	Yes
SNAPI	Yes
WoL	Yes
Power consumption	15 W–150 W

Supported OCP cards

Table 10. Supported OCP cards

Form factor	Vendor	Port type	Port speed	Port count
OCP 3.0	Broadcom	SFP28	25 GbE	4
	Broadcom	SFP28	25 GbE	2
	Intel	SFP28	25 GbE	4
	Intel	SFP28	25 GbE	2
	Broadcom	BT	10 GbE	4
	Broadcom	SFP+	10 GbE	2

Table 10. Supported OCP cards (continued)

Form factor	Vendor	Port type	Port speed	Port count
	Broadcom	ВТ	1 GbE	4
	Intel	SFP	1 GbE	4
	Broadcom	Q56	100 GbE	2

OCP NIC 3.0 vs. rack Network Daughter Card comparisons

Table 11. OCP 3.0, 2.0, and rNDC NIC comparison

Form Factor	Dell rNDC	OCP 2.0 (LOM Mezz)	OCP 3.0	Notes
PCle Gen	Gen 3	Gen 3	Gen 4	Supported OCP3 are SFF (small form factor)
Max PCIe Lanes	x8	Up to x16	Up to x16	See server slot priority matrix
Shared LOM	Yes	Yes	Yes	This is iDRAC port redirect
Aux Power	Yes	Yes	Yes	Used for Shared LOM



PCIe subsystem

Topics:

• PCle risers

PCIe risers

Shown below are the riser offerings for the platform.

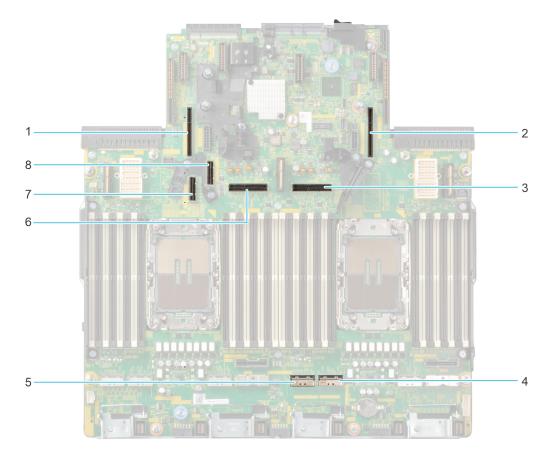


Figure 13. Riser connector location on system board

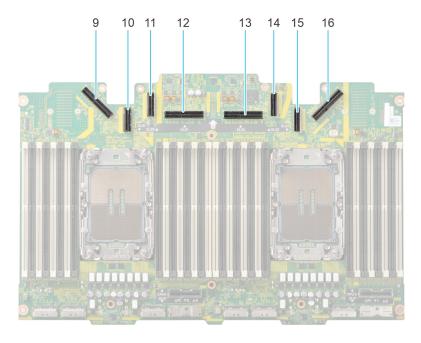


Figure 14. Riser connector location on PEM board

- 1. Riser 4A/4B/4C slot
- Riser 2 cable slot / Riser 3B cable slot
 NOTE: If present, riser 2 uses the connector, otherwise riser 3B uses it.
- 5. Riser 1B cable slot
- 7. Riser 4B cable slot
- 9. Riser 4A/4B/4C cable slot
- 11. Riser 3B cable slot
- 13. Riser 3A/3B cable slot () NOTE: If riser 2 is present, riser 3A/3B uses this connector.
- 15. Riser 3B cable slot

- 2. Riser 1A/1B/1C slot
- 4. Riser 1B cable slot
- 6. Riser 2 cable slot / Riser 3B cable slot

 NOTE: If present, riser 2 uses the connector, otherwise riser 3B uses it.
- 8. Riser 4B cable slot
- 10. Riser 3B cable slot
- 12. Riser 3A/3B cable slot () NOTE: If riser 2 is present, riser 3A/3B uses this connector.
- 14. Riser 3B cable slot
- 16. Riser 1A/1B/1C cable slot

(i) NOTE: A riser can be connected to the riser slot or riser cable slot or both depending on the type of riser used.

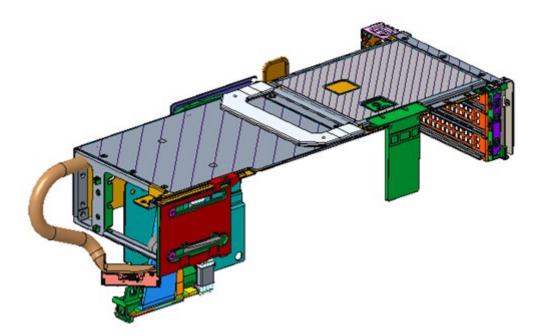


Figure 15. Riser 1A (FL)

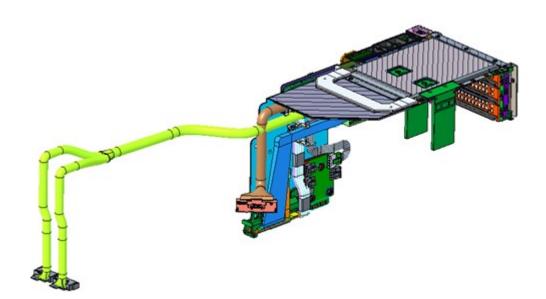


Figure 16. Riser 1B

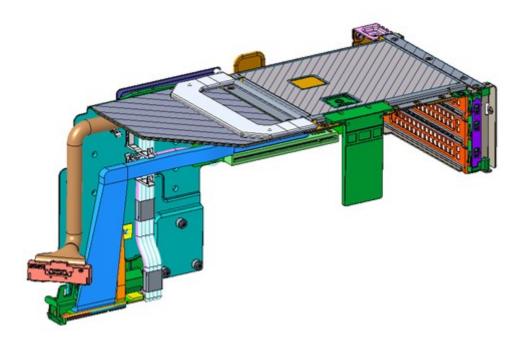


Figure 17. Riser 1C

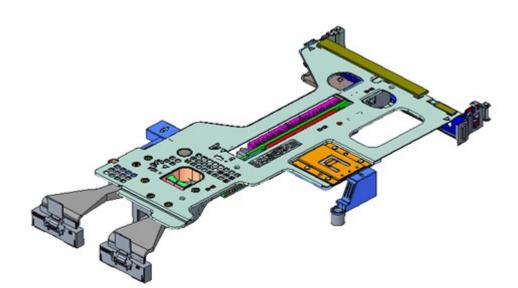


Figure 18. Riser 2

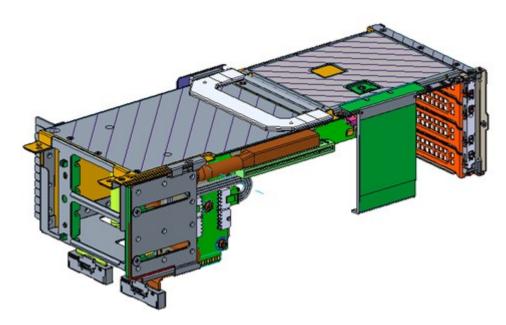


Figure 19. Riser 3A (FL)

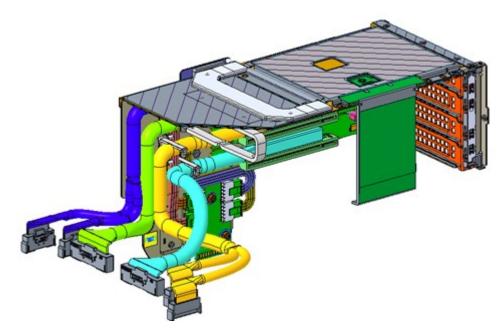


Figure 20. Riser 3B

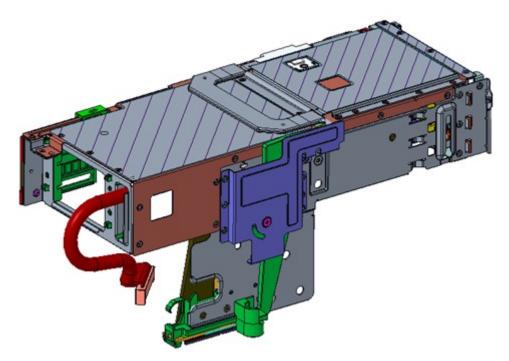


Figure 21. Riser 4A (FL)

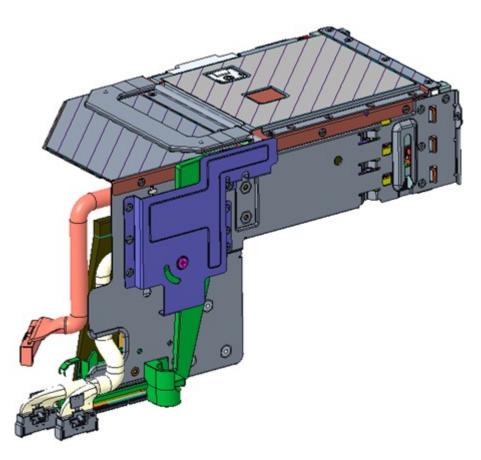


Figure 22. Riser 4B

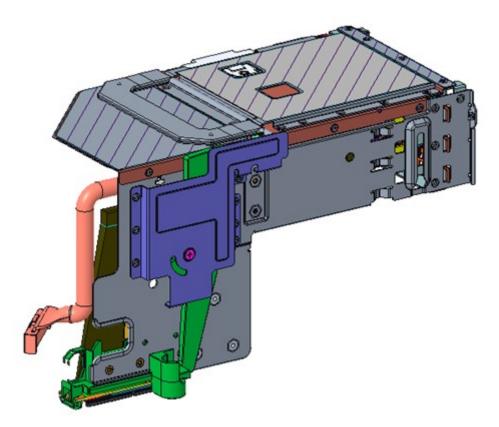


Figure 23. Riser 4C

Table 12. PCIe Riser Configurations

Config No.	Riser configuration	No. of Processors	PERC type supported	Rear storage possible
0-1 (Basic entry)	R1C+R4C	4	Front PERC	No
0-2 (Basic entry)	R1C+R4C	2	Front PERC	No
1 (Scale out)	R1C+R3B+R4C	4	Front PERC	No
2 (Maximum I/O)	R1B+R2+R3B+R4B	4	Front PERC	No
3 (GPU)	R1A+R2+R3A+R4A (FL)	4	Front PERC	No

Table 13. Riser Config 0-1: R1C+R4C

Supporting P	rocessor			CPU3	CPU1	CPU4	CPU2
Location	Width	Length	Height	R1C		R4C	
PCIe Slot-1	SW	HL	FH	Gen5 x16	-	-	-
PCIe Slot-3	SW	HL	FH	-	Gen5 x16	-	-
PCIe Slot-10	SW	HL	FH	-	-	Gen5 x16	-
PCIe Slot-11	SW	HL	FH	-	-	-	Gen5 x16

Table 14. Riser Config 0-2: R1C+R4C

Supporting P	rocessor			CPU3	CPU1	CPU4	CPU2	
Location	Width	Length	Height	R1C		R4C		
PCle Slot-1	SW	HL	FH	NA	-	-	-	
PCle Slot-3	SW	HL	FH	-	Gen5 x16	-	-	
PCIe Slot-10	SW	HL	FH	-	-	NA	-	

Table 14. Riser Config 0-2: R1C+R4C (continued)

Supporting Processor				CPU3	CPU1	CPU4	CPU2
Location	Width	Length	Height	R1C		R4C	
PCle Slot-11	SW	HL	FH	-	-	-	Gen5 x16

Table 15. Riser Config 1: R1C+R3B+R4C

Supporting Processor				CPU3	CPU1	CPU4	CPU2	CPU3	CPU1	CPU4	CPU2	
Location	Width	Length	Height	R1C		R3B	•	•		R4C		
PCle Slot-1	SW	HL	FH	Gen5 x16	-	-	-	-	-	-	-	
PCle Slot-3	SW	HL	FH	-	Gen5 x16	-	-	-	-	-	-	
PCle Slot-5	SW	HL	FH	-	-	Gen5 x16	-	-	-	-	-	
PCle Slot-6	SW	HL	FH	-	-	-	Gen5 x16	-	-	-	-	
PCle Slot-7	SW	HL	FH	-	-	-	-	Gen5 x16	-	-	-	
PCle Slot-8	SW	HL	FH	-	-	-	-	-	Gen5 x16	-	-	
PCle Slot-10	SW	HL	FH	-	-	-	-	-	-	Gen5 x16	-	
PCle Slot-11	SW	HL	FH	-	-	-	-	-	-	-	Gen5 x16	

Table 16. Riser Config 2: R1B+R2+R3B+R4B

Supporting Processor			CPU1	CPU3	CPU1	CPU2	CPU3	CPU4		CPU2	
Location	Width	Length	Height	R1B	-	R2		R3B	-	R4B	
PCle Slot-1	SW	HL	FH	-	Gen5 x16	-	-	-	-	-	-
PCle Slot-2	SW	HL	FH	Gen5 x16	-	-	-	-	-	-	-
PCle Slot-3	SW	HL	FH	Gen5 x16	-	-	-	-	-	-	-
PCle Slot-4	SW	HL	LP	-	-	-	Gen5 x16	-	-	-	-
PCle Slot-5	SW	HL	FH	-	-	-	-	-	Gen5 x16	-	-
PCle Slot-6	SW	HL	FH	-	-	-	-	-	Gen5 x16	-	-
PCle Slot-7	SW	HL	FH	-	-	-	-	Gen5 x16	-	-	-
PCle Slot-8	SW	HL	FH	-	-	-	-	Gen5 x16	-	-	-
PCle Slot-9	SW	HL	LP	-	-	Gen5 x16	-	-	-	-	-
PCIe Slot-10	SW	HL	FH	-	-	-	-	-	-	Gen5 x16	-
PCIe Slot-11	SW	HL	FH	-	-	-	-	-	-	-	Gen5 x16
PCle Slot-12	SW	HL	FH	-	-	-	-	-	-	-	Gen5 x16

Table 17. Riser Config 3: R1A+R2+R3A+R4A

Supporting Processor			CPU1	CPU3	CPU1	CPU2	CPU3	CPU4		CPU2	
Location	Width	Length	Height	R1A		R2		R3A		R4A	1
PCle Slot-1	SW	FL	FH	-	Gen5 x16	-	-	-	-	-	-
PCle Slot-3	DW	FL	FH	Gen5 x16	-	-	-	-	-	-	-
PCle Slot-4	SW	HL	LP	-	-	-	Gen5 x16	-	-	-	-
PCle Slot-6	DW	FL	FH	-	-	-	-	-	Gen5 x16	-	-
PCle Slot-8	DW	FL	FH	-	-	-	-	Gen5 x16	-	-	-
PCle Slot-9	SW	HL	LP	-	-	Gen5 x16	-	-	-	-	-
PCle Slot-10	SW	FL	FH	-	-	-	-	-	-	Gen5 x16	-
PCIe Slot-11	DW	FL	FH	-	-	-	-	-	-	-	Gen5 x16

Power, thermal, and acoustics

PowerEdge servers have an extensive collection of sensors that automatically track thermal activity, which helps to regulate temperature by reducing server noise and power consumption. The table below lists the tools and technologies Dell offers to lower power consumption and increase energy efficiency.

Topics:

- Power
- Thermal
- Acoustics

Power

Table 18. Power tools and technologies

Feature	Description
Power Supply Units(PSU) portfolio	Dell's PSU portfolio includes intelligent features such as dynamically optimizing efficiency while maintaining availability and redundancy. Find additional information in the Power supply units section.
Tools for right sizing	Enterprise Infrastructure Planning Tool (EIPT) is a tool that can help you determine the most efficient configuration possible. With Dell's EIPT, you can calculate the power consumption of your hardware, power infrastructure, and storage at a given workload. Learn more at www.dell.com/calc.
Industry Compliance	Dell's servers are compliant with all relevant industry certifications and guide lines, including 80 PLUS, Climate Savers and ENERGY STAR.
Power monitoring accuracy	PSU power monitoring improvements include:
	 Dell's power monitoring accuracy is currently 1%, whereas the industry standard is 5% More accurate reporting of power Better performance under a power cap
Power capping	Use Dell's systems management to set the power cap limit for your systems to limit the output of a PSU and reduce system power consumption. Dell is the first hardware vendor to leverage Intel Node Manager for circuit-breaker fast capping.
Systems Management	iDRAC Enterprise and Datacenter provides server-level management that monitors, reports and controls power consumption at the processor, memory and system level.
	Dell OpenManage Power Center delivers group power management at the rack, row, and data center level for servers, power distribution units, and uninterruptible power supplies.
Active power management	Intel Node Manager is an embedded technology that provides individual server-level power reporting and power limiting functionality. Dell offers a complete power management solution comprised of Intel Node Manager accessed through Dell iDRAC9 Datacenter and OpenManage Power Center that allows policy-based management of power and thermal at the individual server, rack, and data center level. Hot spare reduces power consumption of redundant power supplies. Thermal control off a speed optimizes the thermal settings for your environment to reduce fan consumption and lower system power consumption.
	Idle power enables Dell servers to run as efficiently when idle as when at full workload.
Rack infrastructure	Dell offers some of the industry's highest-efficiency power infrastructure solutions, including:

Table 18. Power tools and technologies (continued)

Feature	Description
	 Power distribution units (PDUs) Uninterruptible power supplies (UPSs) Energy Smart containment rack enclosures Find additional information at: https://www.delltechnologies.com/en-us/servers/power-and-cooling.htm.

Power Supply Units

Energy Smart power supplies have intelligent features, such as the ability to dynamically optimize efficiency while maintaining availability and redundancy. Also featured are enhanced power-consumption reduction technologies, such as high-efficiency power conversion and advanced thermal-management techniques, and embedded power-management features, including high-accuracy power monitoring. The table below shows the power supply unit options that are available for the R960.

Table 19. Power Supply Unit Options

Wattage	Frequency	Voltage/Current	Class	Heat dissipation
1100 W mixed	50/60 Hz	100–240 Vac/12—3.6 A	Titanium	4100 BTU/hr
mode	N/A	240 Vdc/5.2 A	N/A	4100 BTU/hr
1400 W mixed	50/60 Hz	100–240 Vac/12—8 A	Platinum	5250 BTU/hr
mode	N/A	240 Vdc/6.6 A	N/A	5250 BTU/hr
1800 W mixed	50/60 Hz	200–240 Vac/10 A	Titanium	6750 BTU/hr
mode	N/A	240 Vdc/8.2 A	N/A	6750 BTU/hr
2400 W mixed	50/60 Hz	100–240 Vac/ 16—13.5 A	Platinum	9000 BTU/hr
mode	N/A	240 Vdc/11.2 A	N/A	9000 BTU/hr
2800 W mixed	50/60 Hz	200–240 Vac/15.6 A	Titanium	10,500 BTU/hr
mode	N/A	240 Vdc/13.6 A	N/A	10,500 BTU/hr

NOTE: If a system with AC 2400 W PSUs operates at low line 100-120 Vac, and then the power rating per PSU is degraded to 1400 W.

(i) NOTE: If a system with AC 1400 W or 1100 W PSUs operates at low line 100-120 Vac, and then the power rating per PSU is degraded to 1050 W.



Figure 24. PSU power cords

Table 20. PSU power cords

Form factor	Output	Power cord
Redundant 60 mm	1100 W AC	C13
	1400 W AC	C13
	1800 W AC	C15

Table 20. PSU power cords (continued)

Form factor	Output	Power cord
Redundant 86 mm	2400 W AC	C19
	2800 W AC	C21

(i) NOTE: C19 power cord combined with C20 to C21 jumper power cord can be used to adapt 2800 W PSU.

(i) NOTE: C13 power cord combined with C14 to C15 jumper power cord can be used to adapt 1800 W PSU.

Thermal

PowerEdge servers have an extensive collection of sensors that automatically track thermal activity, which helps regulate temperature thereby reducing server noise and power consumption.

Thermal design

Thermal management of the platform helps deliver high performance with the right amount of cooling to components, while maintaining the lowest fan speeds possible. This is done across a wide range of ambient temperatures from 10°C to 35°C (50°F to 95°F) and to extended ambient temperature ranges.

1. Reliability	 Component hardware reliability remains the top thermal priority. System thermal architectures and thermal control algorithms are designed to ensure there are no tradeoffs in system level hardware life.
2. Performance	 Performance and uptime are maximized through the development of cooling solutions that meet the needs of even the densest of hardware configurations.
3. Efficiency	 16G servers are designed with an efficient thermal solution to minimize power and airflow consumption, and/or acoustics for acoustical deployments. Dell's advanced thermal control algorithms enable minimization of system fans speeds while meeting the above Reliability and Performance tenets.
4. Management	 System management settings are provided such that customers have options to customize for their unique hardware, environments, and/or workloads.
5. Forward Compatibility	 Forward compatibility means that thermal controls and thermal architecture solutions are robust to scale to new components that historically would have otherwise required firmware updates to ensure proper cooling. The frequency of required firmware updates is thus reduced.

Figure 25. Thermal design characteristics

The thermal design of the PowerEdge R960 reflects the following:

- Optimized thermal design: The system layout is architected for optimum thermal design.
- System component placement and layout are designed to provide maximum airflow coverage to critical components with minimum expense of fan power.
- Comprehensive thermal management: The thermal control system regulates the fan speed based on several different responses from all system-component temperature sensors, and inventory for system configurations. Temperature monitoring includes components such as processors, DIMMs, chipset, the inlet air ambient, hard disk drives, and OCP.
- Open and closed loop thermal fan speed control: Open loop thermal control uses system configuration to determine fan speed based on inlet air ambient temperature. Closed loop thermal control method uses feedback temperatures to dynamically determine proper fan speeds.
- User-configurable settings: With the understanding and realization that every customer has unique set of circumstances or expectations from the system, in this generation of servers, we have introduced limited user- configurable settings residing in the iDRAC BIOS setup screen. For more information, see the Dell PowerEdge R960 Installation and Service Manual at

www.dell.com/poweredgemanuals and "Advanced Thermal Control: Optimizing across Environments and Power Goals" on Dell.com.

- Cooling redundancy: The R960 allows N+1 fan redundancy, allowing continuous operation with one fan failure in the system.
- Environmental Specifications: The optimized thermal management makes the R960 reliable under a wide range of operating environments.

Acoustics

Acoustical configurations of R960

Dell PowerEdge R960 is a rack or tower server appropriate for attended data center environment. However, lower acoustical output is attainable with proper hardware or software configurations.

Table 21. Configurations tested for acoustical experience

Configuration	Quietest	HCI	Data Management	Machine Learning	
CPU TDP	Intel (Gold 6) 195 W	Intel (Gold 6) 250 W	Intel (Gold 6) 250 W	Intel (Platinum 8) 350 W	
CPU Quantity	U Quantity 4		4	4	
RDIMM Memory	IMM Memory 16G DDR5 4800 MHz		64G DDR5 4800 MHz	64G DDR5 4800 MHz	
Memory Quantity	4	32	48	64	
Backplane Type	2.5" x 32 BP	2.5" x 32 BP	2.5" x 16 BP	2.5" x 32 BP	
HDD Type	IDD Type SAS TOSHIBA AL15SE 2.5" 600 GB		SAS TOSHIBA AL15SE 2.5" 1.2 TB	SAS Seagate Skybolt 2.5" 1.8 TB	
HDD Quantity	32	32	16	32	
M.2 Drives	Hynix NVMe 480G	Hynix NVMe 480G	Hynix NVMe 480G	Hynix NVMe 480G	
M.2 Quantity	1	1	1	1	
PSU Type	ARTESYN 2400 W	LITEON 2800 W	ARTESYN 2400 W	LITEON 2800 W	
PSU Quantity	J Quantity 4		4	4	
OCP	CP X		Intel OCP3 10G 2-port	Intel OCP3 10G 2-port	
PCI 1	X	Х	X	X	
PCI 2	X	Х	Nvidia A16 250W	X	
PCI 3	Х	Х	X	X	
PCI 4	Х	Х	X	X	
PCI 5	Х	Х	X	X	
PCI 6	Х	Х	X	X	
PCI 7	Х	Х	X	X	
PCI 8	X	Х	X	X	
PCI 9	Х	Х	X	X	
PCI 10	X	X	N∨idia A16 250 W	X	
PCI 11	X	Х	X	X	
PCI 12	X	X	X	X	
PERC	Front H755	Front H755	Front H755	Front H755	

Table 22. Acoustical experience of R960 configurations

Configuratio	n	Quietest	нсі	Data Management	Machine Learning		
Acoustical Per	rformance: Idle/ Operating @ 25	o ^o C Ambient	`				
L _{wA,m} (B)	Idle ⁽⁴⁾	5.4	6.0	6.0	5.6		
	Operating/Customer usage operating ⁽⁵⁾⁽⁶⁾	5.7	6.3	7.5	6.7		
К _v (В)	Idle (4)	0.4	0.4	0.4	0.4		
	Operating/Customer usage operating ⁽⁵⁾⁽⁶⁾	0.4	0.4	0.4	0.4		
L _{pA,m} (dB)	Idle ⁽⁴⁾	39	44	44	41		
	Operating/Customer usage operating ⁽⁵⁾⁽⁶⁾	43	47	60	53		
Prominent dis	crete tones ⁽³⁾	Prominence ratio < 15 dB					
Acoustical Per	rformance: Idle @ 28°C Ambient	[
L _{wA,m} ⁽¹⁾ (B)		6.1	6.6	6.9	6.4		
К _v (В)		0.4	0.4	0.4	0.4		
L _{pA,m} ⁽²⁾ (dB)		45	51	54	49		
Acoustical Per	rformance: Max. loading @ 35°C	C Ambient			·		
L _{wA,m} ⁽¹⁾ (B)		7.5	7.8	9.0	9.2		
К _v (В)		0.4	0.4	0.4	0.4		
$L_{pA,m}^{(2)}(dB)$		60	63	74	77		

⁽¹⁾LwA,m: The declared mean A-weighted sound power level (LwA) is calculated per section 5.2 of ISO 9296 (2017) with data collected using the methods that are described in ISO 7779 (2010). Engineering data presented here may not be fully compliant with ISO 7779 declaration requirement.

⁽²⁾LpA,m: The declared mean A-weighted emission sound pressure level is at the bystander position per section 5.3 of ISO 9296 (2017) and measured using methods that are described in ISO 7779 (2010). The system is placed in a 24U rack enclosure, 25 cm above a reflective floor. Engineering data presented here may not be fully compliant with ISO 7779 declaration requirement.

⁽³⁾Prominent tones: Criteria of Annex D of ECMA-74 and Prominence Ratio method of ECMA-418 are followed to determine if discrete tones are prominent and to report them, if so.

⁽⁴⁾Idle mode: The steady-state condition in which the server is energized but not operating any intended function.

⁽⁵⁾Operating mode: The maximum of the steady state acoustical output at 50% of CPU TDP or active storage drives for the respective sections of Annex C of ECMA-74.

⁽⁶⁾ Customer Usage Operating mode: The operating mode is represented by the maximum of the steady state acoustical output at 25%~30% of CPU TDP, 2.5%~10% IOPs load, and >80% GPU load as the components showed in the above configurations.

PowerEdge acoustical specifications

For more information about acoustical specifications, see ENG0019663. (See the category definitions.)

Dell typically categorizes servers in five categories of acoustically acceptable usage:

- Category 1: Table-top in Office Environment
- Category 2: Floor-standing in Office Environment
- Category 3: General Use Space
- Category 4: Attended Data Center
- Category 5: Unattended Data Center

Category 1: Floor-standing in Office Environment

When Dell determines that a specific Enterprise product is to be used on a table-top in office environment, for example, on a desk around a seated user's head height, and then the acoustical specification of the following table applies. Small, light-weight towers are examples of these types of products.

Table 23. Dell Enterprise Category 1, "Table-top in Office Environment" acoustical specification category.

Measurement Position re	Metric, re AC0159	Test Modes, re AC0159 (note must be in steady state, see AC0159, except where noted below)						
AC0158		Standby in 23±2° C Ambient	Idle in 23±2° C Ambient	Operating in 23±2° C Ambient – if not otherwise specified in the program's configuration document, then processor and hard drive operating modes are required	Simulate (that is, set fan speeds representative) for Idle at 28° C & 35° C Ambient, and for 100% loading and maximum configuration, at 35° C Ambient			
Sound Power	LwA-m, bels	≤ 4.2	≤ 4.7	≤ 5.0	Report			
Sound Quality (both positions	Tones, Hz, dB	No prominent to ECMA-74	nes per criteria D.10	Report tones				
must meet limits): Front	Tonality, tu	≤ 0.35	≤ 0.35	≤ 0.35	Report			
Binaural HEAD and Rear Microphone	Dell Modulation, %	≤ 35	≤ 35	≤ 35	Report			
Microphone	Loudness, sones	Report	Report	Report	Report			
	LpA-single point, dBA	Report	Report	Report	Report			
Front Binaural HEAD	Transients	 minute steady the following Max. {ΔLp Event couting Acoustical mover spection Acoustical mover spection Startup behation Report Station Startup misudden or startup misudden or startup misudden to startup misubal m	bA < 3.0 dB unt < 3 for "1.5 dB < I Jump (see AC015 eed transition from st be \leq 15 dB. vior artup behavior re. / nust proceed smoot r large jumps, and fa ust not exceed 509 uts: Report time-hi- ils re AC0159 "Trair	N/A				
Any	Other	No rattles, squeaks, or unexpected noises Sound should be "even" around the EUT (one side should not be dramatically loude another) Unless otherwise specified, the "default" thermal-related settings shall be selected BIOS and iDRAC. Specific operating conditions will be defined in "Configurations & Configuration Dependencies" for each platform.						

Table 23. Dell Enterprise Category 1, "Table-top in Office Environment" acoustical specification category. (continued)

Measurement Position re AC0158	Metric, re AC0159	Test Modes, re AC0159 (note must be in steady state, see AC0159, except where noted below)				
		Standby in 23±2° C Ambient	ldle in 23±2° C Ambient	Operating in 23±2° C Ambient – if not otherwise specified in the program's configuration document, then processor and hard drive operating modes are required	Simulate (that is, set fan speeds representative) for Idle at 28° C & 35° C Ambient, and for 100% loading and maximum configuration, at 35° C Ambient	
Sound Pressure	LpA-reported, dBA, re AC0158 and program configuration document	Report for all mics	Report for all mics	Report for all mics	Report for all mics	

Category 2: Floor-standing in Office Environment

When Dell determines that a specific Enterprise product is to be used primarily when it is sitting on the floor, that is, next to a user's feet, then the acoustical specification in the table below applies. Noise from the product should not annoy or otherwise interfere with the user's thoughts or speech, for example, on the telephone.

Table 24. Dell Enterprise Category 2, "Floor-standing in Office Environment" acoustical specification category

Measurement Position re AC0158	Metric, re AC0159	Test Modes, re AC0159 (note must be in steady state, see AC0159, except where noted below)				
		Standby in 23±2° C Ambient	ldle in 23±2° C Ambient	Operating in 23±2° C Ambient – if not otherwise specified in the program's configuration document, then processor and hard drive operating modes are required	Simulate (that is, set fan speeds representative) for Idle at 28° C & 35° C Ambient, and for 100% loading and maximum configuration, at 35° C Ambient	
Sound Power	LwA-m, bels	≤ 4.9	≤ 5.1	≤ 5.4	Report	
Sound Quality (both positions must meet limits): Front Binaural HEAD and Rear Microphone	Tones, Hz, dB	No prominent tones per criteria D.10.6 and D.10.8 of ECMA-74			Report tones	
	Tonality, tu	≤ 0.35	≤ 0.35	≤ 0.35	Report	
	Dell Modulation, %	≤ 35	≤ 35	≤ 35	Report	
	Loudness, sones	Report	Report	Report	Report	
	LpA-single point, dBA	Report	Report	Report	Report	
Front Binaural HEAD	Transients	minute steady the following	ee AC0159), if obse v-state observation two criteria: bA} < 3.0 dB	N/A		

Table 24. Dell Enterprise Category 2, "Floor-standing in Office Environment" acoustical specification category (continued)

Measurement Position re	Metric, re AC0159	Test Modes, re noted below)	Test Modes, re AC0159 (note must be in steady state, see AC0159, except where noted below)				
AC0158		Standby in 23±2° C Ambient	Idle in 23±2° C Ambient	Operating in 23±2° C Ambient – if not otherwise specified in the program's configuration document, then processor and hard drive operating modes are required	Simulate (that is, set fan speeds representative) for Idle at 28° C & 35° C Ambient, and for 100% loading and maximum configuration, at 35° C Ambient		
		 Acoustical Jun speed transiti must be ≤ 15 Startup behav o Report Sta o Startup m sudden or startup m Transient input 	vior artup behavior re. v ust proceed smoot large jumps, and fa ust not exceed 509 uts: Report time-hi s re AC0159 "Trair	during air mover erating Mode AC0159 hly, that is, no an speed during % of its maximum story sound			
Any	Other	 Sound should than another) Unless otherw BIOS and iDR. Specific operation 	vise specified, the AC.	the EUT (one side "default" thermal-r e defined in "Confi	should not be dramatically louder related settings shall be selected for gurations and Configuration		
Sound Pressure	LpA-reported, dBA, re AC0158 and program configuration document	Report for all mics	Report for all mics	Report for all mics	Report for all mics		

Category 3: General Use Space

When Dell determines that a specific Enterprise product is to be predominantly used in a general use space, then the acoustical specification of the table below applies. These products could be found in laboratories, schools, restaurants, open office space layouts, small ventilated closets, etc., though not in close proximity to any particular person nor in quantities greater than a few in any location. People within proximity of a few of these products should not experience any impact to speech intelligibility or annoyance from the noise of the product. A rack product sitting on a table in a common area is an example.

Table 25. Dell Enterprise Category 3, "General Use" acoustical specification category

Measurement Position re	Metric, re AC0159	Test Modes, re AC0159 (note must be in steady state, see AC0159, except where noted below)				
AC0158		Standby in 23±2° C Ambient	ldle in 23±2° C Ambient	Operating in 23±2° C Ambient – if not otherwise specified in the program's configuration document, then processor and hard drive operating modes are required	Simulate (that is, set air mover speeds representative) for Idle at 28° C & 35° C Ambient and for 100% loading and maximum configuration, at 35° C Ambient	
Sound Power	LwA-m, bels	≤ 5.2	≤ 5.5	≤ 5.8	Report	
Sound Quality (both positions	Tones, Hz, dB	No prominent tor ECMA-74	nes per criteria D.10).6 and D.10.8 of	Report tones	
must meet limits): Front	Tonality, tu	≤ 0.35	≤ 0.35	≤ 0.35	Report	
Binaural HEAD and Rear Microphone	Dell Modulation, %	≤ 40	≤ 40	≤ 40	Report	
Microphone	Loudness, sones	Report	Report	Report	Report	
	LpA-single point, dBA	Report	Report	Report	Report	
Front Binaural HEAD	Transients	 minute steady the following Max. {ΔLp Event cou Report Acous mover speed Mode. Startup behave Report State Startup mesudden or during state Transient input 	A} < 3.0 dB nt < 3 for "1.5 dB - tical Jump (see AC transition from Idle vior artup behavior re. <i>J</i> ust proceed smoot large jumps, and a rtup must not exce uts: Report time-hi ls re AC0159 "Trair	a, must adhere to < ΔLpA < 3.0 dB" 20159) during air a to Operating AC0159 shly, that is, no ir mover speed sed 50% of its story sound	N/A	
Any	Other	Sound should be another) Unless otherwise BIOS and iDRAC.	specified, the "de g conditions will be	EUT (one side sho fault" thermal-rela	ould not be dramatically louder than ted settings shall be selected for gurations & Configuration	
Sound Pressure	LpA-reported, dBA, re AC0158 and program configuration document	Report for all mics	Report for all mics	Report for all mics	Report for all mics	

Category 4: Attended Data Center

When Dell determines that a specific Enterprise product is to be predominantly used in an attended data center, then the acoustical specification of the table applies. The phrase "attended data center" is used to mean a space in which many (from tens to 1000s) of Enterprise products are deployed in proximity (that is, in the same room) to personnel whose speech (perhaps with raised voices) is expected to be intelligible over the data center noise. Hearing protection or hearing monitoring programs are not expected in these areas. Examples in this category include monolithic rack products.

Table 26. Dell Enterprise Category 4, "Attended Data Center" acoustical specification category.

Measurement Position re AC0158	Metric, re AC0159	Test Modes, re AC0159, excep	e AC0159 (note mu ot where noted bel	ıst be in steady s ow)	tate, see	Simulate (that is, set fan
		Standby in 23±2° C Ambient	Idle in 23±2° C Ambient	Operating in 23±2° C Ambient – if not otherwise specified in the program's configuration document, then processor and hard drive operating modes are required	Simulate (that is, set fan speeds representative) for Idle at 28° C & 35° C Ambient	speeds representative) for 100% loading and maximum configuration, at 35° C Ambient
Sound Power	LwA-m, B	Report	≤ 6.9	≤ 7.1	Report	≤ 8.2
Front Binaural	Tones, Hz, dB	Report	< 15 dB	< 15 dB	Report	< 20 dB
HEAD	Tonality, tu	Report	Report	Report	Report	Report
	Dell Modulation, %	Report	Report	Report	Report	Report
	Loudness, sones	Report	Report	Report	Report	Report
	LpA-single point, dBA	Report	Report	Report	Report	Report
	Transients	minute stead the following ○ Max. {ΔL ○ Event co ○ Acoustic mover sp Mode mu ○ Startup k ■ Repo ■ Start no su during maxir	rt Startup behavior up must proceed sm Idden or large jumps g startup must not e num uts: Report time-his re AC0159 "Train of	a, must adhere to < ΔLpA < 3.0 dB" 9), during air Idle to Operating re. AC0159 noothly, that is, , and fan speed exceed 50% of its	N/A	
Any	Other	Sound should be another)	eaks, or unexpected e "even" around the se specified, the "der C.	EUT (one side sho		-

Table 26. Dell Enterprise Category 4, "Attended Data Center" acoustical specification category. (continued)

Measurement Position re AC0158	Metric, re AC0159	Test Modes, re AC0159, except	Simulate (that is, set fan			
		Standby in 23±2° C Ambient	ldle in 23±2° C Ambient	Operating in 23±2° C Ambient – if not otherwise specified in the program's configuration document, then processor and hard drive operating modes are required	Simulate (that is, set fan speeds representative) for Idle at 28° C & 35° C Ambient	speeds representative) for 100% loading and maximum configuration, at 35° C Ambient
		Specific operating conditions will be defined in "Configurations & Configuration Dependencies" for each platform.				
Sound Pressure	LpA-reported, dBA	Report for all mics	Report for all mics	Report for all mics	Report for all mics	Report for all mics

Category 5: Unattended Data Center

When Dell determines that a specific Enterprise product is to be predominantly used in an unattended data center (and not blades or blade enclosures; these have their own category), then the acoustical specification in the table below applies. The phrase "unattended data center" is used to mean a space in which many (from tens to 1000s) of Enterprise products are deployed together, its own heating and cooling systems condition the space, and operators or servicers of equipment enter generally only to deploy, service, or decommission equipment. Hearing protection or hearing monitoring programs may be expected (per government or company guidelines) in these areas. Examples in this category include monolithic rack products.

Table 27. Dell Enterprise Category 5, "Unattended Data Center" acoustical specification category

Measuremen t Position re	Metric, re AC0159	Test Modes, re AC0159 (note must be in steady state, see AC0159, except where noted below)			teady state, see AC0159,	Simulate (that is, set air
AC0158		Standby in 23±2° C Ambient	Idle in 23±2° C Ambient	Operating in 23±2° C Ambient – if not otherwise specified in the program's configuratio n document, then processor and hard drive operating modes are required	Simulate (that is, set air mover speeds representative) for Idle at 28° C & 35° C Ambient	mover speeds representative) for 100% loading and maximum configuration, at 35° C Ambient
Sound Power	LwA-m, bels	Report	≤ 7.5	≤ 7.7	Report	≤ 8.7
Front Binaural	Tones, Hz, dB	Report	< 15 dB	< 15 dB	Report	< 20 dB
HEAD	Tonality, tu	Report	Report	Report	Report	Report
	Dell Modulation, %	Report	Report	Report	Report	Report
	Loudness, sones	Report	Report	Report	Report	Report

Table 27. Dell Enterprise Category 5, "Unattended Data Center" acoustical specification category (continued)

Measuremen t Position re AC0158	Metric, re AC0159	Test Modes, except where	Simulate (that is, set air mover speeds			
		Standby in 23±2° C Ambient	Idle in 23±2° C Ambient	Operating in 23±2° C Ambient – if not otherwise specified in the program's configuratio n document, then processor and hard drive operating modes are required	Simulate (that is, set air mover speeds representative) for Idle at 28° C & 35° C Ambient	representative) for 100% loading and maximum configuration, at 35° C Ambient
	LpA-single point, dBA	Report	Report	Report	Report	Report
Front Binaural HEAD	Transients	 observed, of observation two criteria Max. {A Event of 3.0 dB" Report Accorduring air nuldle to Ope Startup belor Report Startup belor Startup is, no su mover se exceed Transient in sound pres 	LpA} < 3.0 dB ount < 3 for "1.5 pustical Jump (se nover speed tran rating Mode.	e steady-state o the following o dB < ΔLpA < ee AC0159) histion from r re. AC0159 moothly, that mps, and air rtup must not mum ne-history C0159 "Train of	N/A	
Any	Other	Sound should b another)		d the EUT (one	side should not be dramatically	
		and iDRAC.	ting conditions v		nal-related settings shall be sel "Configurations & Configuratio	
Sound Pressure	LpA-reported, dBA, re AC0158 and program configuration document	Report for all mics	Report for all mics	Report for all mics	Report for all mics	Report for all mics

Rack, rails, and cable management

Topics:

• Rails and cable management information

Rails and cable management information

The rail offerings for the PowerEdge R960 consist of one sliding type. The cable management offerings consist of an optional cable management arm (CMA) and an optional strain relief bar (SRB).

See the Enterprise Systems Rail Sizing and Rack Compatibility Matrix available at https://i.dell.com/sites/csdocuments/ Business_solutions_engineering-Docs_Documents/en/rail-rack-matrix.pdf for information regarding:

- Specific details about rail types.
- Rail adjustability ranges for various rack mounting flange types.
- Rail depth with and without cable management accessories.
- Rack types that are supported for various rack mounting flange types.

Key factors governing proper rail selection include the following:

- Spacing between the front and rear mounting flanges of the rack.
- Type and location of any equipment that is mounted in the back of the rack such as power distribution units (PDUs).
- Overall depth of the rack.

Sliding rails features summary

The sliding rails allow the system to be fully extended out of the rack for service. There is one type of sliding rails available, Stab-in/Drop-in sliding rails. The sliding rails are available with or without the optional cable management arm (CMA) or strain relief bar (SRB).

B19 Stab-in/Drop-in sliding rails for 4-post racks

- Supports drop-in or stab-in installation of the chassis to the rails.
- Support for tool-less installation in 19" EIA-310-E compliant square, unthreaded round hole racks including all generations of the Dell racks. Also supports tool-less installation in threaded round hole 4-post racks.
- Support for tool-less installation in Dell Titan or Titan-D racks.
- Support full extension of the system out of the rack to allow serviceability of key internal components.
- Support for optional cable management arm (CMA).
- Support for optional strain relief bar (SRB).

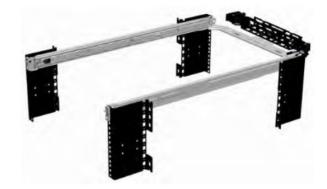


Figure 26. Sliding rails with optional CMA



Figure 27. Sliding rails with optional SRB

Scan the QRL code for the documentation and trouble-shooting information regarding the installation procedures for Drop-in/Stab-in rail types.



Figure 28. Quick resource locator for combo rails

Installation in the Dell Titan or Titan-D racks

For tool-less installation in Titan or Titan-D racks, the Stab-in/Drop-in sliding rails (B19) must be used. This rail collapses down sufficiently to fit in the rack with mounting flanges that are spaced about 24 inches apart from front to back. The Stab-in/Drop-in sliding rail allows bezels of the servers and storage systems to be aligned when installed in these racks.

Cable management arm (CMA)

The optional cable management arm (CMA) organizes and secures the cords and cables exiting the back of the systems. It unfolds to allow the systems to extend out of the rack without having to detach the cables. Some key features of the CMA include:

- Large U-shaped baskets to support dense cable loads.
- Open vent pattern for optimal airflow.
- Ability to mount on either side by swinging the spring-loaded brackets from one side to the other.
- Utilizes hook-and-loop straps rather than plastic tie wraps to eliminate the risk of cable damage during cycling.
- Includes a low-profile fixed tray to both support and retain the CMA in its fully closed position.
- Both the CMA and the tray mount without the use of tools by simple and intuitive snap-in designs.

For systems with one power supply unit (PSU), it is recommended to mount on the side opposite to that of the power supply to allow easier access to it and the rear drives (if applicable) for service or replacement.



Figure 29. Sliding rails with CMA

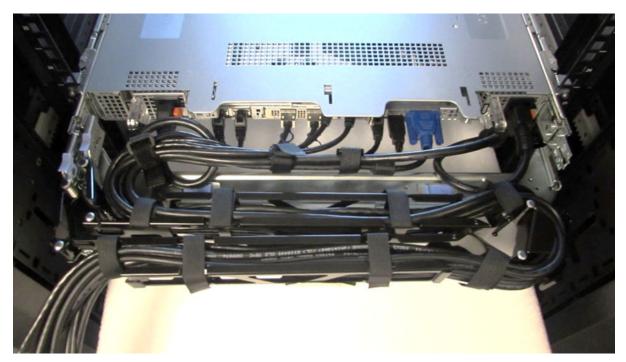


Figure 30. CMA Cabling

Strain Relief Bar (SRB)

The optional strain relief bar (SRB) for the PowerEdge R960 organizes and supports cable connections at the rear end of the server to avoid damage from bending.

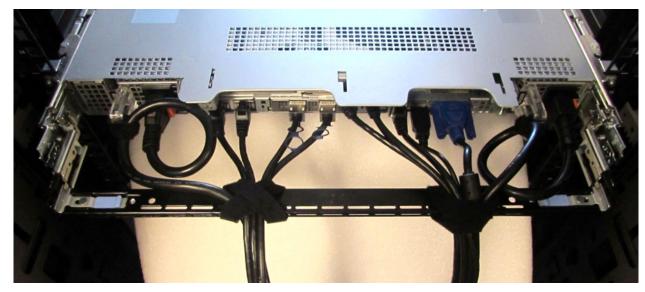


Figure 31. Cabled strain relief bar

- Tool-less attachment to the rails
- Two depth positions to accommodate various cable loads and rack depths
- Supports cable loads and controls stresses on server connectors
- Cables can be segregated into discrete purpose-specific bundles

Rack Installation

Drop-in design means that the system is installed vertically into the rails by inserting the standoffs on the sides of the system into the J-slots in the inner rail members with the rails in the fully extended position. The recommended method of installation is to first insert the rear standoffs on the system into the rear J-slots on the rails to free up a hand and then rotate the system down into the remaining J-slots while using the free hand to hold the rail against the side of the system.

Stab-in design means that the inner (chassis) rail members must first be attached to the sides of the system and then inserted into the outer (cabinet) members installed in the rack.

Installing system into the rack (option A: Drop-In)

1. Pull the inner rails out of the rack until they lock into place.



Figure 32. Pull out inner rail

- 2. Locate the rear rail standoff on each side of the system and lower them into the rear J-slots on the slide assemblies.
- **3.** Rotate the system downward until all the rail standoffs are seated in the J-slots.

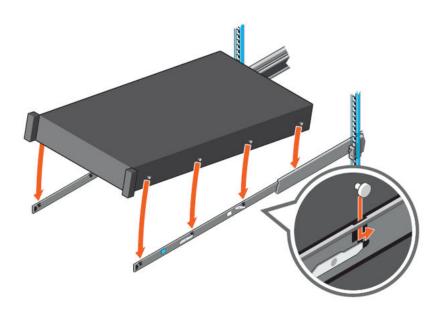


Figure 33. Rail standoffs seated in J-slots

- **4.** Push the system inward until the lock levers click into place.
- 5. Pull the blue side release lock tabs forward or backward on both rails and slide the system into the rack until the system is in the rack.

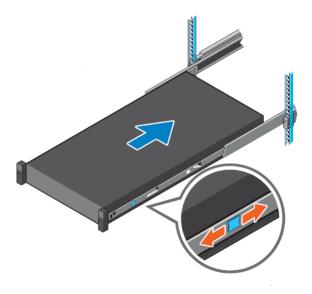


Figure 34. Slide system into the rack

Installing the system into the rack (option B: Stab-In)

- 1. Pull the intermediate rails out of the rack until they lock into place.
- 2. Release the inner rail lock by pulling forward on the white tabs and sliding the inner rail out of the intermediate rails.

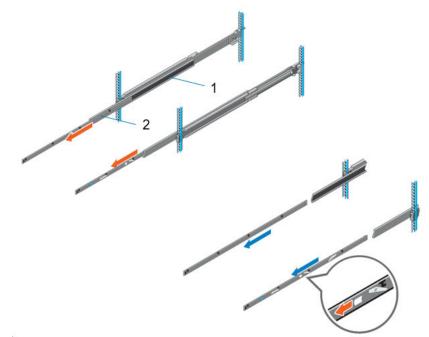


Figure 35. Pull out the intermediate rail

Table 28. Rail component label

Number	Component
1	Intermediate rail
2	Inner rail

3. Attach the inner rails to the sides of the system by aligning the J-slots on the rail with the standoffs on the system and sliding forward on the system until they lock into place.

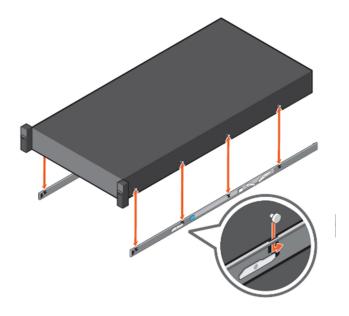


Figure 36. Attach the inner rails to the system

4. With the intermediate rails extended, install the system into the extended rails.

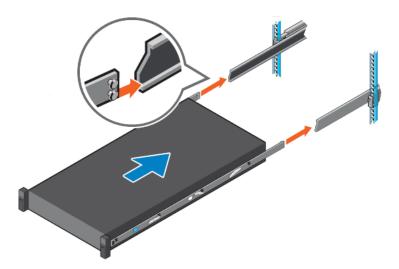


Figure 37. Install system into the extended rails

5. Pull blue slide release lock tabs forward or backward on both rails, and slide the system into the rack.

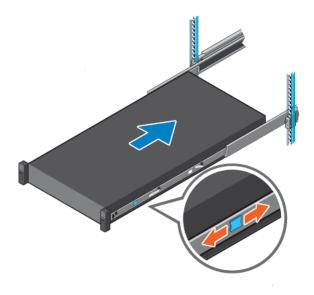


Figure 38. Slide system into the rack

Operating Systems and Virtualization

Topics:

• Supported Operating Systems

Supported Operating Systems

The PowerEdge system supports the following operating systems:

- Canonical® Ubuntu® Server LTS
- Microsoft® Windows Server® with Hyper-V
- Red Hat® Enterprise Linux
- SUSE® Linux Enterprise server
- VMware® ESXi®

Links to specific OS versions and editions, certification matrices, Hardware Compatibility Lists (HCL) portal, and Hypervisor support are available at Dell Enterprise Operating Systems.

Dell OpenManage Systems Management

Dell delivers management solutions that help IT administrators effectively deploy, update, monitor, and manage IT assets. OpenManage solutions and tools enable you to quickly respond to problems by helping them to manage Dell servers efficiently; in physical, virtual, local, and remote environments; all without the need to install an agent in the operating system.

The OpenManage portfolio includes:

- Innovative embedded management tools integrated Dell Remote Access Controller (iDRAC)
- Consoles OpenManage Enterprise
- Extensible with plug-ins OpenManage Power Manager
- Update tools Repository Manager

Dell has developed comprehensive systems management solutions that are based on open standards and has integrated with management consoles from partners such as Microsoft and VMware, allowing advanced management of Dell servers. Dell management capabilities extend to offerings from the industry's top systems management vendors and frameworks such as Ansible, Splunk, and ServiceNow. OpenManage tools automate the full span of server life cycle management activities along with powerful RESTful APIs to script or integrate with your choice of frameworks.

For more information about the entire OpenManage portfolio, see:

• The latest Dell Systems Management Overview Guide.

(i) NOTE: OpenManage Software and OpenManage Integration will be available from September 2023.

Topics:

- Integrated Dell Remote Access Controller (iDRAC)
- Systems Management software support matrix

Integrated Dell Remote Access Controller (iDRAC)

iDRAC9 delivers advanced, agent-free, local and remote server administration. Embedded in every PowerEdge server, iDRAC9 provides a secure means to automate a multitude of common management tasks. Because iDRAC is embedded within every PowerEdge server, there is no additional software to install; just plug in power and network cables, and iDRAC is ready to go. Even before installing an operating system (operating system) or hypervisor, IT administrators have a complete set of server management features at their fingertips.

With iDRAC9 in-place across the Dell PowerEdge portfolio, the same IT administration techniques and tools can be applied throughout. This consistent management platform allows easy scaling of PowerEdge servers as an organization's infrastructure grows. Customers can use the iDRAC RESTful API for the latest in scalable administration methods of PowerEdge servers. With this API, iDRAC enables support for the Redfish standard and enhances it with Dell extensions to optimize at-scale management of PowerEdge servers. By having iDRAC at the core, the entire OpenManage portfolio of Systems Management tools allows every customer to tailor an effective, affordable solution for any size environment.

Zero Touch Provisioning (ZTP) is embedded in iDRAC. ZTP - Zero Touch Provisioning is Intelligent Automation Dell's agent-free management puts IT administrators in control. Once a PowerEdge server is connected to power and networking, that system can be monitored and fully managed, whether you're standing in front of the server or remotely over a network. In fact, with no need for software agents, an IT administrator can: • Monitor • Manage • Update • Troubleshoot and remediate Dell servers With features like zero-touch deployment and provisioning, iDRAC Group Manager, and System Lockdown, iDRAC9 is purpose-built to make server administration quick and easy. For those customers whose existing management platform utilizes in-band management, Dell does provide iDRAC Service Module, a lightweight service that can interact with both iDRAC9 and the host operating system to support legacy management platforms.

When ordered with DHCP enabled from the factory, PowerEdge servers can be automatically configured when they are initially powered up and connected to your network. This process uses profile-based configurations that ensure each server is configured per your specifications. This feature requires an iDRAC Enterprise license.

iDRAC9 offers following license tiers:

Table 29. iDRAC9 license tiers

License	Description
iDRAC9 Basic	 Available only on 100-500 series rack/tower Basic instrumentation with iDRAC web UI For cost conscious customers that see limited value in management
iDRAC9 Express	 Default on 600+ series rack/tower, modular, and XR series Includes all features of Basic Expanded remote management and server life-cycle features
iDRAC9 Enterprise	 Available as an upsell on all servers Includes all features of Basic and Express. Includes key features such as virtual console, AD/LDAP support, and more Remote presence features with advanced, Enterprise-class, management capabilities
iDRAC9 Datacenter	 Available as an upsell on all servers Includes all features of Basic, Express, and Enterprise. Includes key features such as telemetry streaming, Thermal Manage, automated certificate management, and more Extended remote insight into server details, focused on high end server options, granular power, and thermal management

For a full list of iDRAC features by license tier, see Integrated Dell Remote Access Controller 9 User's Guide at Dell.com.

For more details on iDRAC9 including white papers and videos, see:

• Support for Integrated Dell Remote Access Controller 9 (iDRAC9) on the Knowledge Base page at Dell.com

Systems Management software support matrix

Table 30. Systems Management software support matrix

Categories	Features	PE mainstream
Embedded Management and In-band	iDRAC9 (Express, Enterprise, and Datacenter licenses)	Supported
Services	OpenManage Mobile	Supported
	OM Server Administrator (OMSA)	Supported
	iDRAC Service Module (iSM)	Supported
	Driver Pack	Supported
Change Management	Update Tools (Repository Manager, DSU, Catalogs)	Supported
	Server Update Utility	Supported
	Lifecycle Controller Driver Pack	Supported
	Bootable ISO	Supported
Console and Plug-ins	OpenManage Enterprise	Supported
	Power Manager Plug-in	Supported
	Update Manager Plug-in	Supported
	SupportAssist Plug-in	Supported
	CloudIQ	Supported
Integrations and connections	OM Integration with VMware Vcenter/vROps	Supported
	OM Integration with Microsoft System Center (OMIMSC)	Supported
	Integrations with Microsoft System Center and Windows Admin Center (WAC)	Supported

Table 30. Systems Management so	oftware support matrix ((continued)
---------------------------------	--------------------------	-------------

Categories	Features	PE mainstream
	ServiceNow	Supported
	Ansible	Supported
	Third-party Connectors (Nagios, Tivoli, Microfocus)	Supported
Security	Secure Enterprise Key Management	Supported
	Secure Component Verification	Supported
Standard operating system	Red Hat Enterprise Linux, SUSE, Windows Server 2021 Ubuntu, CentOS	Supported (Tier-1)

(i) NOTE: OpenManage Software and OpenManage Integration will be available from October 2023.

Appendix D: Services

Topics:

- Default service levels
- ProDeploy Infrastructure Suite
- Supplemental Deployment Services
- Unique Deployment Scenarios
- DAY 2 Automation Services with Ansible
- ProSupport Infrastructure Suite
- Specialty Support Services
- Consulting Services
- Resources

Default service levels

Dell sales tools like DSA, OSC, Guided Journey, DellStar and others are defaulted with standard configurations to make quoting easier. The system defaults for services all C-Series platforms is listed below:

- 1. **Support default:** 3 years, ProSupport Next BusinessDay (NBD) Onsite service which includes comprehensive 24x7 predictive and reactive support for hardware and software.
- 2. Deployment default: ProDeploy for C-Series Compute Sled which includes onsite hardware installation and software configuration. Note: Deployment of the C-Series chassis enclosure (the metal frame) is included at no additional charge as part of the C-Series deployment service for the sled. Optionally, the customer may choose any other factory or field deployment offers listed below.

ProDeploy Infrastructure Suite

ProDeploy Infrastructure Suite provides a variety of deployment offerings to satisfy a customer's unique needs. It is made up of five sub-offers: **Configuration Services**, **Rack Integration**, **Basic Deployment**, **ProDeploy**, and **ProDeploy Plus**.

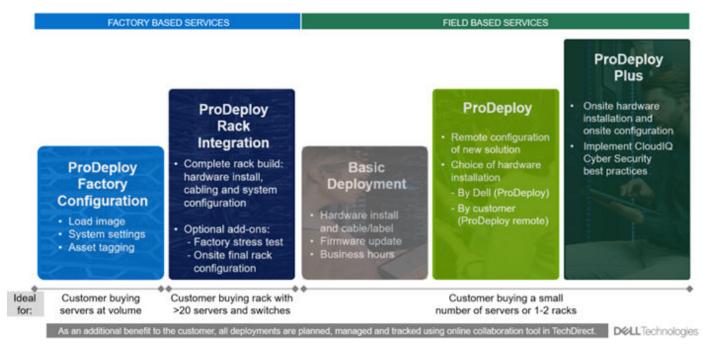


Figure 39. ProDeploy Infrastructure Suite

Factory Based Services

Pre-configured systems or complete racks, customized prior to shipping to the customer's site.

ProDeploy Factory Configuration

Ideal for customers buying servers in volume and seeking pre-configuration prior to shipping such as: custom image, system settings, and asset tagging so it arrives ready to use out of the box. Furthermore, servers are packaged and bundled to meet specific shipping and distribution requirements for each customer location to facilitate the rollout process. Once the server is onsite Dell, can install and configure the server to the environment using any of the field-based deployment services outlined in the next section.

ProDeploy Rack Integration

Ideal for customers seeking to build out fully integrated racks prior to shipping. These rack builds include hardware install, cabling, and full system configuration. You can also add-on a factory stress test and optional on-site final rack configuration to complete the rack installation.

- STANDARD SKUs for Rack Integration is available in USA only and requires:
 - 20 or more devices (R and C series servers, VxRail and all Dell or non-Dell switches)
 - Use Informational SKUs for Dell switches or 3rd party products
 - Shipping to contiguous USA
 - USE CUSTOM QUOTE for Rack Integration scenarios that require:
 - Shipment to any country outside USA or shipping outside contiguous USA
 - Shipping to multiple locations
 - Racks containing less than 20 servers
 - Any rack that includes Storage

ProDeploy Infrastructure Suite | Factory based services

		ProDeploy Factory Configuration	ProDeploy Rack Integration 1
	Single point of contact for project management	•	•
	RAID, BIOS and iDRAC configuration	•	•
Asset Configuration	Firmware freeze	•	•
comgulation	Asset Tagging and Reporting	•	•
	Customer system image	•	•
	Site readiness review and implementation planning	1.00	•
Deployment	Hardware racking and cabling		•
	Deployment verification, documentation, and knowledge transfer	•	•
	White glove logistics	1.1	•
Post-	Onsite final configuration		Optional
deployment	Install support software and connect with Dell Technologies	100 B	Opuonar
	Optional add on of Basic Deployment	Optional	21
Online collaboration	Online collaborative environment for planning, managing and tracking delivery	•	•

Figure 40. ProDeploy Infrastructure Suite - Factory services

Field-based Services

Put PowerEdge servers to work faster with Dell field-based deployment services. Whether we are deploying one server to one thousand – we have you covered. Dell provides versatile delivery options to fit every budget and operating model.

ProDeploy Plus

Elevate Infrastructure deployments with our most complete service from planning through onsite hardware installation and software configuration including the implementation of cybersecurity best practices. ProDeploy Plus provides the skill and scale needed to successfully execute demanding deployments in today's complex IT . The deployment starts with a site readiness review and implementation plan. Certified deployment experts perform the software configuration to include set up of leading operating systems and hypervisors. Dell will also configure PowerEdge software tools to include iDRAC and OpenManage system utilities as well as support AlOps platforms: MenvironmentsyService360, TechDirect and CloudIQ. Unique to ProDeploy Plus, the cybersecurity implementation helps customers understand potential security risks and make recommendations for reducing product attack surfaces. The system is tested, validated prior to completion. The customer will also receive full project documentation and knowledge transfer to complete the process.

ProDeploy

ProDeploy provides remote software configuration and choice of hardware installation (onsite or guided). ProDeploy is great for customers who are price sensitive or willing to participate in some portion of the deployment to include providing remote access to their network. The ProDeploy remote software implementation includes everything mentioned in ProDeploy Plus except it does not include the added value, cybersecurity implementation and best practices.

Basic Deployment

Basic Deployment delivers worry-free professional installation by experienced technicians. This service is often sold to Competency Enabled Partners who will have Dell do the hardware installation while they complete the software configuration. Furthermore, Basic Deployment tends to be purchased by large enterprises who have smart technical staff. These companies just need Dell to install the hardware and they will perform the software configuration. The last use case for Basic Deployment is when paired with Factory Configuration services. The servers are pre-configured in the factory and the basic deployment service will install the system into the rack to finalize the deployment.

ProDeploy Infrastructure Suite | Field services

		Basic Deployment	ProDeploy	ProDeploy Plus
Pre-	Single point of contact for project management		•	In region
deployment	Site readiness review and implementation planning		•	•
	Deployment service hours	Business hours	24/7	24/7
	Hardware installation options	Onsite	Onsite or guided 1	Onsite
Deployment	System software installation and configuration options	2	Remote	Onsite
	Install connectivity software based on Secure Connect Gateway technology 2		•	•
	Implement CloudIQ CyberSecurity best practices and policies			•
Post-	Deployment verification, documentation and knowledge transfer		•	•
deployment	Configuration data transfer to Dell technical support		•	•
Online collaboration	Online collaborative platform in TechDirect for planning, managing and tracking delivery		•	•

¹ Choose from onsite hardware installation or a guided option including project specific instructions, documentation and live expert guidance

² Post deployment use for intelligent, automated support & insights

Figure 41. ProDeploy Infrastructure Suite - Field services

Supplemental Deployment Services

Additional ways to expand scope or deploy for unique scenarios.

Expand scope and transition	Unique deployment scenarios
Two Host Adder (requires PD/PDP)	"Custom" Service Engagement
Additional Deployment Time (ADT) (Sold with or without PD/ PDP)	ProDeploy Add-on for HPC
Data Migration	ProDeploy Plus for Direct Liquid Cooling (DLC 3000)
Residency Services (onsite or remote)	ProDeploy for TELCO

Two Host Adder (requires PD/PDP)

Deploying new storage, compute, or networking devices may require interconnection to other servers (also called hosts). The Dell delivery team will set up four hosts per device as part of every ProDeploy service. For example, if the customer is buying two storage arrays the ProDeploy service will automatically include connectivity of four hosts each (4x2=8 total hosts per project since there are two devices). This supplemental "Two Host Adder" service provides for the configuration of additional hosts above what is already provided as part of the ProDeploy service. In many cases, customers can work with us while we set up the included hosts, so they may understand how to do the rest themselves. Always ask the customer how many hosts are being connected and sell the host adder depending on the customer's technology skill-set. Note this service applies to the connectivity of Dell devices not 3rd party devices.

Additional Deployment Services (ADT) - sold with or without PD/PDP

You can expand the scope of a ProDeploy engagement leveraging Additional Deployment Time (ADT). ADT will cover additional tasks above the normal deliverables of the ProDeploy offers. ADT can also be used as a standalone service without ProDeploy. SKUs are available for both Project Management and Technical Resource Expertise. SKUs are sold as blocks of four hours remote or eight hours onsite. The delivery team can assist in identifying the number of hours required for additional tasks.

Data Migration Services

Migrating data sets is no easy task. Our experts use proven tools and process to streamline data migrations and avoid compromising data. A customer project manager works with our experienced team of experts to create a migration plan. Data migration is part of every technology upgrade, platform change, and shift to the cloud. You can rely on Dell data migration services to perform a seamless transition

Residency Services

Certified technical professionals act like an extension of your IT staff to enhance internal capabilities and resources and help you realize faster adoption and maximized ROI of new technology. Residency Services help customers transition to new capabilities quickly by leveraging specific technology skill sets. Residency experts can provide post implementation management and knowledge transfer that is related to a new technology acquisition or day-to-day operational management of the IT infrastructure.

- Global experts available to serve in-person (onsite) or virtual (remote)
- Engagements starting at 2 weeks with flexibility to adjust

Unique Deployment Scenarios

Custom Deployment Services

When a deployment is beyond the scope of the ProDeploy Infrastructure Suite you can turn to the custom deployment services team to address complex implementation scenarios and customer unique requirements. The Dell custom deployment team is staffed with solution architects who will assist with customer scoping calls to define the project and develop the statement of work. Custom services can handle a wide range of deployments that can be performed in the factory or onsite. All custom engagement services are requested through SFDC.

Deployment of HPC

High-Performance Computing (HPC) implementations require specialists that understand advanced feature sets. Dell deploys the world's fastest systems and understands the nuancesthat make them perform. HPC deployments are most often scoped as custom service engagements, however we can do smaller HPC clusters under 300 nodes using a standard ProDeploy SKU. Any standard SKU for HPC deployment will be sold as one base SKU per cluster (ProDeploy for HPC Base) along with one ProDeploy for HPC Add-on for each device in the cluster (server nodes and switches).

• Scope of ProDeploy for HPC: *Available as standard SKUs in US and Canada. Custom Service would be required for all other regions.

ProDeploy for HPC*	HPC Add-on for Nodes
 Install & configure Cluster Management software Configure HPC nodes & switches Validate implemented design Perform cluster benchmarking Product orientation Per cluster 	 Rack & Stack Server Nodes Professionally labeled cabling BIOS configured for HPC OS installed Per node
Non-Tied BASE SKU SKU per new cluster (regardless of cluster size)	Tied & Non-Tied Add-on SKUs SKU/asset If over 300 nodes use custom quote

Figure 42. Standard deliverables of ProDeploy for HPC

Build HPC solutions for your unique requirements

Choose ProDeploy for HPC or Custom deploy

ProDeploy service includes configuration of most OS, cluster mgmt., networking and benchmarking



Figure 43. Visual view of HPC deployment options to include hardware and software

DAY 2 - Automation Services with Ansible

Dell solutions are built as "automation ready" with integrated APIs (Application Programming Interfaces) to allow customers to programmatically call actions on the product through code. Although Dell has published Anisble automation use cases, some customers need additional assistance with GitOps. By the end of the service, the customer will have the foundational components required to accelerate automation and understand how the programming works together: Day 1 and Day 2 use case automation scripts (ansible modules), CI/CD tool (Jenkins), and Version control (Git).

ProSupport Infrastructure Suite

ProSupport Infrastructure Suite is a set of support services that enable customers to build the solution that is right for their organization. They choose support models that are based on how they use technology and where they want to allocate resources. From the desktop to the data center, customers can address everyday IT challenges, such as unplanned downtime, mission-critical needs, data and asset protection, support planning, resource allocation, software application management and more. Optimize customer IT resources by choosing the right support model.

ProSupport Plus for Infrastructure

Service that caters to customers who require proactive, predictive, and personalized support for systems that manage critical business applications and workloads. When customers purchase PowerEdge server, we recommend ProSupport Plus, our proactive and preventative support service for business-critical systems. ProSupport Plus provides all the benefits of ProSupport, including the following "Top five reasons to buy PSP".

- 1. Priority access to specialized support experts immediate, advanced troubleshooting from an engineer that understands Dell infrastructure solutions.
- 2. Mission Critical Support when critical (Severity 1) support issues happen, the customer is assured that we will do all we can to get them back up and running as quickly as possible.
- **3.** Service Account Manager a customer's #1 support advocate, ensuring they get the best possible proactive and predictive support experience.
- **4.** Systems maintenance on a semi-annual basis, we will keep a customer's ProSupport Plus system(s) up to date by installing the latest firmware, BIOS, and driver updates to improve performance and availability.
- 5. 3rd party software support Dell is a customer's single point of accountability for any eligible 3rd party software installed on their ProSupport Plus system, whether they purchased the software from us or not.

ProSupport for Infrastructure

Comprehensive 24x7 support for hardware and software - best for production, but not critical, workloads and applications. The ProSupport service offers highly trained experts around the clock and around the globe to address IT needs. We help minimize disruptions and maximize availability of PowerEdge server workloads with:

- 24x7 support through phone, chat and online
- A central point of accountability for all hardware and software issues
- Hypervisor, operating system and application support
- Dell security advisories
- Onsite response service levels 4 hour or Next Business Day options
- Proactive issue detection with automated case creation
- Predictive hardware anomaly detection
- Incident Manager assigned for Severity 1 cases
- Collaborative third-party support
- Access to AIOps Platforms (MyService360, TechDirect, and CloudIQ)
- Consistent experience regardless of where customers are located or what language they speak

Basic Hardware Support

Provides reactive hardware support during normal business hours, excluding local national holidays. No software support or software related guidance. For improved levels of support choose ProSupport or ProSupport Plus.

ProSupport Infrastructure Suite | Enhanced value across all offers!

	Basic Hardware Support	ProSupport for Infrastructure	ProSupport Plus for Infrastructure	Changes with August 2023 release
Technical support availability and response objective	9/5, immediate	24/7, immediate	24/7, immediate	No change
Covered products	Hardware	Hardware & Software	Hardware & Software	No change
Onsite response service level	NBD	NBD or 4-hour	4-hour	ProSupport Plus NBD is retired
ProSupport AIOps platforms	•	•	•	MyService360 and TechDirect (all offers) CloudIQ (ProSupport & ProSupport Plus)
Dell Security Advisories		•	•	Available on additional products
Proactive issue detection with automated case creation	•	•	•	New to Basic
Predictive hardware anomaly detection		•	•	New to ProSupport
Access to software updates		•	•	No change
CloudIQ health and cybersecurity monitoring & analytics		•	•	Enhanced features
Incident Manager for Severity 1 cases		•	•	No change
Mission Critical support			•	Enhanced features
Priority access to remote senior support engineers1			•	No change
Service Account Manager			•	No change
Proactive system maintenance			•	No change
Limited 3 rd party software support ²			•	No change

¹Based on availability ²Software license can be purchased through Dell or BYOL - see Service Descriptions for details

D&LLTechnologies

Figure 44. ProSupport Enterprise Suite

Specialty Support Services

Optional specialty support services complement the ProSupport Infrastructure Suite to provide additional proficiencies that are critical for modern data center operations.

Hardware coverage add-ons to ProSupport

- Keep Your Hard Drive (KYHD) and Keep Your Component (KYC): Normally if a device fails under warranty, Dell replaces it using a one-for-one exchange process. KYHD / KYC gives you the option to retain your device. It provides full control of sensitive data and minimizes security risk by letting you retain possession of failed drives / components when receiving replacement parts without incurring additional cost.
- **Onsite Diagnosis Service:** Ideal for sites with non-technical staff. Dell field technician performs initial troubleshooting diagnosis onsite and transfers to Dell remote engineers to resolve the issue.
- ProSupport Add-on for HPC Sold as an add-on to a ProSupport service contract, the ProSupport Add-on for HPC provides solution-aware support to cover the additional requirements that are required to maintain an HPC environment such as:
 - Access to senior HPC experts
 - Advanced HPC cluster assistance: performance, interoperability, and configuration
 - Enhanced HPC solution level end-to-end support
 - Remote pre-support engagement with HPC Specialists during ProDeploy implementation
- **ProSupport Add-on for Telco (Respond & Restore):** An add-on service designed for the top 31 TELCO customers globally, Respond & Restore provides direct access to Dell solution experts who specialize in TELCO carrier-grade support. This add-on also provides a hardware uptime guarantee, meaning if a system fails, Dell will have it installed and operational within 4 hours for Severity 1 issues. Dell incurs penalties and fees if SLAs are not met.

Supplemental Site-wide Expertise

- **Multivendor Support Service:** Support your 3rd party devices as one service plan for servers, storage and networking (includes coverage for: Broadcom, Cisco, Fujitsu, HPE, Hitachi, Huawei, IBM, Lenovo, NetApp, Oracle, Quanta, SuperMicro & others).
- **Technical Account Manager:** Designated technology lead who monitors and manages performance and configuration of specific technology sets.
- Designated Remote Support: Personalized support expert who manages all troubleshooting and resolution of IT assets

Services for large enterprises

- **ProSupport One for Data Center:** ProSupport One for Data Center offers flexible site-wide support for large and distributed data centers with more than 1,000 assets (combined total of server, storage, networking, etc.). This offering is built on standard ProSupport features that leverage our global scale and are tailored to specific customer needs. While not for everyone, this service option offers a truly unique solution for our largest customers with the most complex environments.
 - Team of assigned Services Account Managers with remote or onsite options
 - Assigned technical and field engineers who are trained on the customer's environment and configurations
 - On-demand reporting and recommendations enabled by ProSupport AIOps tools (MyService360, TechDirect & CloudIQ)
 - Flexible onsite support and parts options that fit their operational model
 - A tailored support plan and training for their operations staff

Logistics Online Inventory Solution (LOIS):

Ideal for large organizations that have their own staff to support their data center. Dell offers a service called Logistics Online Inventory Solution which is an onsite parts locker that provides self-maintainers with a local inventory of common replacement components. Having access to these parts lockers allows the self-maintainer to replace a failed component immediately without delay. Each replacement part would automatically initiate a replenishment of the parts inventory that is shipped next day or delivered onsite by Dell during a regular scheduled visit (called Scheduled Onsite Service). As part of the LOIS system, customers can integrate their systems directly to Dell TechDirect using APIs to help streamline the support management process.

End-of-Life Services

- **Post Standard Support (PSS):** Extend service life beyond the initial seven years of ProSupport, adding up to five more additional years of hardware coverage
- Data Sanitization & Data Destruction: Renders data unrecoverable on repurposed or retired products, ensuring security of sensitive data and enabling compliance and provides NIST compliant certification.

• Asset Recovery Services: Recycle, resale, and disposal of hardware. Helps you securely and responsibly retire IT assets that are no longer needed while protecting both your business and the planet.

Consulting Services

Our expert consultants help customers transform faster, and quickly achieve business outcomes for the high value workloads Dell PowerEdge systems can handle. From strategy to full-scale implementation, Dell Technologies Consulting can help determine how to perform IT, workforce, or application transformation. We use prescriptive approaches and proven methodologies that are combined with portfolio and partner ecosystem of Dell Technologies to help achieve real business outcomes. We are here to help guide your next transformation that could address multi-cloud environments, business applications, DevOps, business resiliency, data center modernization, analytics, workforce collaboration, and user experiences.

Managed Services

Some customers prefer Dell to manage the complexity and risk of daily IT operations. Dell Managed Services utilizes proactive, artificial intelligence to improve operations and modern automation. This helps customers realize desired business outcomes from their infrastructure investments. With these technologies, our experts run, update, and fine-tune customer environments. You decide the service level requirements and we provide oversight of the environment. There are two types of managed service offers. First the outsourcing model, or CAPEX model, where Dell manages customer owned assets using our people and tools. The second is the "as-a-Service" model, or OPEX model, which we call APEX. In this service, Dell owns all technology and all the management of it. Many customers will have a blend of the two management types depending on the goals of the organization.

Managed Outsourcing or CAPEX model

We manage your technology using our people and tools.¹

- Managed detection and response*
- Technology Infrastructure
- End-user (PC/desktop)
- Service desk operations
- Cloud Managed (Pub/Private)
- Office365 or Microsoft Endpoint

APEX as-a-Service or OPEX model

We own all technology so you can off-load all IT decisions.

- APEX Cloud Services
- APEX Flex on Demand elastic capacity
- APEX Data Center Utility pay-per-use model

1 - Some minimum device counts may apply. Order via: ClientManagedServices.sales@dell.com

* Managed detection and response covers the security monitoring of laptops, servers, & virtual servers. Min. 50 devices combined. No Networking or Storage-only systems [SAN/NAS]. Available in 32 countries. Details here

Figure 45. Dell Managed Services

- Managed Detection and Response (MDR): Dell Technologies Managed Detection and Response (MDR) is powered by Secureworks Taegis XDR software platform. MDR is a managed service that secures the customer's IT environment against malicious actors and provides remediation if and when a threat is identified. When a customer purchases MDR, they will receive the following features from our team:
 - Dell badge resources
 - Agent rollout assistance to help deploy the Secureworks Endpoint Agent
 - 24x7 threat detection & investigation
 - Up to 40hrs per quarter of response and active remediation activities
 - If the customer experiences a breach, we will provide up to 40hrs per year of Cyber incident response initiation
 - Quarterly reviews with the customer to review the data

Education Services

Build the IT skills required to influence the transformational outcomes of the business. Enable talent and empower teams with the right skills to lead and perform transformational strategy that drives competitive advantage. Leverage the training and certification required for real transformation.

Dell Technologies Education Services offers PowerEdge server training and certifications that are designed to help customers achieve more from their hardware investment. The curriculum delivers the information and the practical, firsthand skills that their team must confidently install, configure, manage, and troubleshoot Dell servers.

To learn more or register for a class today, see Education.Dell.com



Services for PowerEdge.

Appendix A: Additional specifications

Topics:

- Chassis dimension
- Chassis weight
- NIC port specifications
- Video specifications
- USB Ports
- PSU rating
- Environmental specifications

Chassis dimension

The R960 has the following dimensions:

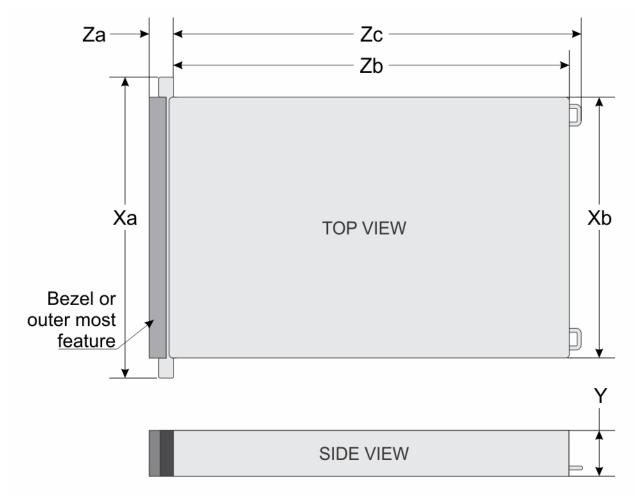


Figure 46. Chassis dimensions

Table 31. Chassis dimensions

Model number	Xa	ХЬ	Y	Za with bezel	Za without bezel	Zb	Zc	Max Sys Wgt	Chassis
R960	482 mm	444 mm	174.3 mm	36 mm	22 mm	844.74 mm	847.195 mm	60.2 kg	4U

Chassis weight

Table 32. Chassis weight

System Configuration	Maximum Weight
A server with fully populated drives	60.2 kg (132.71 lbs)
A server without drives and PSU installed	NA

NIC port specifications

The system supports up to two 10/100/1000 Mbps Network Interface Controller (NIC) ports embedded on the LAN on Motherboard (LOM) card and integrated on the optional OCP cards.

Table 33. NIC port specification for the system

Feature	Specifications
LOM card (optional)	1 GbE x 2
	1 GbE x 4, 10 GbE x 2, 10 GbE x 4, 25 GbE x 2, 25 GbE x 4, 100 GbE x 2

(i) NOTE: The system allows either LOM card or an OCP card or both to be installed in the system.

Video specifications

The PowerEdge R960 system supports integrated Matrox G200 graphics controller with 16 MB of video frame buffer.

Table 34. Video specifications for R960

Resolution	Refresh rate (Hz)	Color depth (bits)	
1024 x 768	60	8, 16, 32	
1280 x 800	60	8, 16, 32	
1280 x 1024	60	8, 16, 32	
1360 x 768	60	8, 16, 32	
1440 x 900	60	8, 16, 32	
1600 x 900	60	8, 16, 32	
1600 x 1200	60	8, 16, 32	
1680 x 1050	60	8, 16, 32	
1920 x 1080	60	8, 16, 32	
1920 x 1200	60	8, 16, 32	

USB Ports

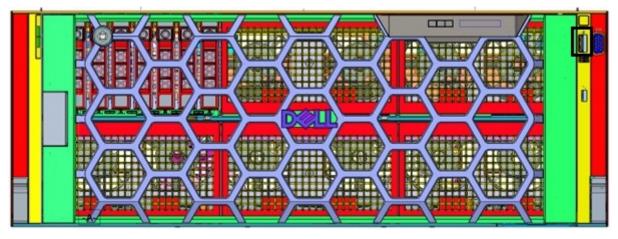


Figure 47. Front USB Port

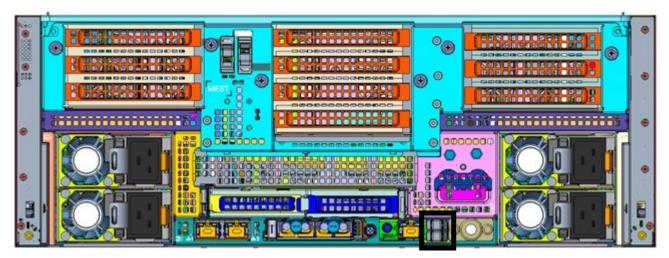


Figure 48. Rear USB Port

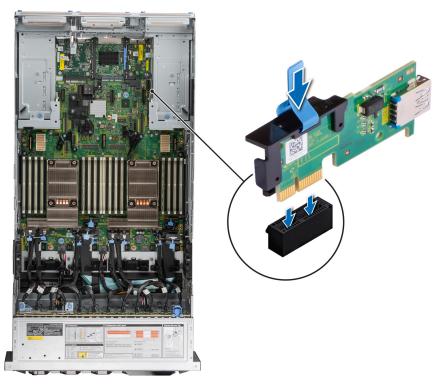


Figure 49. Internal USB Port

Table 35. Systems USB Specifications

Front		Rear		Internal		
USB port type	No. of ports	USB port type	No. of ports	USB port type	No. of ports	
USB x.2.0 – 1 compliant port		USB x.2.0 – compliant port	1	USB x.3.0 – compliant port	1	
		USB x.3.0 – compliant port	1			

PSU rating

Below table lists the power capacity the PSUs in high/low line operation mode.

Table 36. PSUs highline and lowline ratings

_	1100 W Titanium	1400 W Platinum	1800 W Titanium	2400 W Platinum	2800 W Titanium
Peak Power (Highline/-72 VDC)	1870 W	2380 W	3060 W	4080 W	4760 W
Highline/-72 VDC	1100 W	1400 W	1800 W	2400 W	2800 W
Peak Power (Lowline/-40 VDC)	1785 W	1785 W	N/A	2380 W	N/A
Lowline/-40 VDC	1050 W	1050 W	N/A	1400 W	N/A

Table 36. PSUs highline and lowline ratings (continued)

-	1100 W Titanium	1400 W Platinum	1800 W Titanium	2400 W Platinum	2800 W Titanium
Highline 240 VDC	1100 W	1400 W	1800 W	2400 W	2800 W

The PowerEdge R960 supports up to four AC power supplies with 2+2 redundancy, autosensing, and auto switching capability.

A PSU Mismatch occurs when a PSU or a set of PSUs is incompatible with other PSUs in the system. The iDRAC determines PSU compatibility based on a set of tests at both iDRAC boot and when a PSU is hot-plugged into the system. If the platform supports more than 2 PSUs, half the PSUs should be tested the compatibility.

If 2+2 PSUs are present during iDRAC boot, a comparison is made between the wattage capacities of the two sets of PSUs. In the event that the two sets of PSUs wattages don't match, the larger capacity of the two sets of PSUs is enabled. Also, there is a PSU mismatch warning displayed in BIOS, iDRAC, or on the System LCD.

If the second set of PSUs is added at run-time, in order for that second set of PSUs to be enabled, the wattage capacity of the second set of PSUs must equal to the first set of PSU. Otherwise, the second set of PSUs will be flagged as unmatched in iDRAC and the second PSU will not be enabled.

Dell PSUs have achieved Platinum efficiency levels as shown in the table below.

Table 37. PSU efficiency level

Efficiency Targets by Load							
Form factor	Output	Class	10%	20%	50%	100%	
Redundant 60 mm	1100 W AC	Titanium	90.00%	94.00%	96.00%	91.50%	
	1400 W AC	Platinum	89.00%	93.00%	94.00%	91.50%	
	1800 W AC	Titanium	90.00%	94.00%	96.00%	94.00%	
Redundant 86 mm	2400 W AC	Platinum	89.00%	93.00%	94.00%	91.50%	
	2800 W AC	Titanium	90.00%	94.00%	96.00%	94%	

Environmental specifications

(i) NOTE: For additional information about environmental certifications, refer to the Product Environmental Datasheet located with the *Documentation* on www.dell.com/support/home.

Table 38. Continuous Operation Specifications for ASHRAE A2

Temperature	Specifications	
Allowable continuous operati	Allowable continuous operations	
Temperature range for altitudes < 900 m (< 2953 ft)	10-35°C (50-95°F) with no direct sunlight on the equipment	
Humidity percent range (non-condensing at all times)	8% RH with -12°C (10.4°F) minimum dew point to 80% RH with 21°C (69.8°F) maximum dew point	
Operational altitude de- rating	Maximum temperature is reduced by 1°C/300 m (1.8°F/984 Ft) above 900 m (2953 Ft)	

Table 39. Continuous Operation Specifications for ASHRAE A3

Temperature	Specifications
Allowable continuous operations	

Table 39. Continuous Operation Specifications for ASHRAE A3 (continued)

Temperature	Specifications
Temperature range for altitudes <= 900 m (<= 2953 ft)	5-40°C (41-104°F) with no direct sunlight on the equipment
Humidity percent range (non-condensing at all times)	8% RH with -12°C (10.4°F) minimum dew point to 85% RH with 24°C (75.2°F) maximum dew point
Operational altitude de- rating	Maximum temperature is reduced by 1°C/175 m (1.8°F/574 Ft) above 900 m (2953 Ft)

Table 40. Continuous Operation Specifications for ASHRAE A4

Temperature	Specifications	
Allowable continuous operat	Allowable continuous operations	
Temperature range for altitudes <= 900 m (<= 2953 ft)	5–45°C (41–113°F) with no direct sunlight on the equipment	
Humidity percent range (non-condensing at all times)	8% RH with -12°C (10.4°F) minimum dew point to 90% RH with 24°C (75.2°F) maximum dew point	
Operational altitude de- rating	Maximum temperature is reduced by 1°C/125 m (1.8°F/410 Ft) above 900 m (2953 Ft)	

Table 41. Common Environmental Specifications for ASHRAE A2, A3 and A4

Temperature	Specifications
Allowable continuous operations	
Maximum temperature gradient (applies to both operation and non-operation)	20°C in an hour* (36°F in an hour) and 5°C in 15 minutes (9°F in 15 minutes), 5°C in an hour* (9°F in an hour) for tape hardware (i) NOTE: * Per ASHRAE thermal guidelines for tape hardware, these are not instantaneous rates of temperature change.
Non-operational temperature limits	-40 to 65°C (-40 to 149°F)
Non-operational humidity limits (non-condensing at all times)	5% to 95% RH with 27°C (80.6°F) maximum dew point
Maximum non-operational altitude	12,000 meters (39,370 feet)
Maximum operational altitude	3,050 meters (10,006 feet)

Table 42. Maximum vibration specifications

Maximum vibration	Specifications
Operating	0.21 G_{rms} at 5 Hz to 500 Hz for 10 minutes (all operation orientations)
Storage	1.88 $\mathrm{G}_{\mathrm{rms}}$ at 10 Hz to 500 Hz for 15 minutes (all six sides tested)

Table 43. Maximum shock pulse specifications

Maximum shock pulse	Specifications
Operating	Six consecutively executed shock pulses in the positive and negative x, y, and z axis of 6 G for up to 11 ms
Storage	Six consecutively executed shock pulses in the positive and negative x, y, and z axis (one pulse on each side of the system) of 71 G for up to 2 ms

Particulate and gaseous contamination specifications

The following table defines the limitations that help avoid any equipment damage or failure from particulates and gaseous contamination. If the levels of particulates or gaseous pollution exceed the specified limitations and result in equipment damage or failure, you may need to rectify the environmental conditions. Remediation of environmental conditions is the responsibility of the customer.

Table 44. Particulate contamination specifications

Particulate contamination	Specifications
Air filtration	 Data center air filtration as defined by ISO Class 8 per ISO 14644-1 with a 95% upper confidence limit i) NOTE: This condition applies to data center environments only. Air filtration requirements do not apply to IT equipment designed to be used outside a data center, in environments such as an office or factory floor. i) NOTE: Air entering the data center must have MERV11 or MERV13 filtration.
Conductive dust	Air must be free of conductive dust, zinc whiskers, or other conductive particles
Corrosive dust	 Air must be free of corrosive dust Residual dust present in the air must have a deliquescent point less than 60% relative humidity NOTE: This condition applies to data center and non-data center environments.
Walk-Up Edge Data Center or Cabinet (sealed, closed loop environment)	Filtration is not required for cabinets that are anticipated to be opened 6 times or less per year. Class 8 per ISO 1466-1 filtration as defined above is required otherwise (i) NOTE: In environments commonly above ISA-71 Class G1 or that may have known challenges, special filters may be required.

Table 45. Gaseous contamination specifications

Gaseous contamination	Specifications
Copper coupon corrosion rate	<300 Å/month per Class G1 as defined by ANSI/ISA71.04-2013
Silver coupon corrosion rate	<200 Å/month as defined by ANSI/ISA71.04-2013

Thermal restriction matrix

Table 46. Processor and heat sink matrix

Heat sink	Processor TDP
STD HSK	≤ 185 W
L-type HSK	≥ 195 W

Table 47. Label reference

Label	Description
STD	Standard fan
НЅК	Heat sink

Table 47. Label reference (continued)

Label	Description
LP	Low Profile
FH	Full Height

() **NOTE:** The ambient temperature of the configuration is determined by the critical component in that configuration. For example, if the processor's supported ambient temperature is 35°C (95°F), the DIMM is 35°C (95°F), and the GPU is 30°C (86°F), the combined configuration can only support 30°C (86°F).

Table 48. Thermal restriction matrix for air cooled configurations

Configuration			32 x 2.5-inch SAS	16 x 2.5- inch SAS + 8 x 2.5-inch NVMe	24 x 2.5- inch NVMe	16 x 2.5- inch SAS	16 x EDSFF E3.S NVMe	8 x 2.5- inch SAS + 16 x EDSFF E3.S NVMe	8 x 2.5- inch SAS
Rear storage			No Rear Drives	No Rear Drives	No Rear Drives	No Rear Drives	No Rear Drives	No Rear Drives	No Rear Drives
CPU SKUs	TDP	T-Case max center (°C)			Ambie	ent tempe	erature		
6416H	165 W	82	45°C (113°F)	35°C (95°F)	35°C (95°F)	45°C (113°F)	35°C (95°F)	35°C (95°F)	45°C (113°F)
6418H	185 W	81	45°C (113°F)	35°C (95°F)	35°C (95°F)	45°C (113°F)	35°C (95°F)	35°C (95°F)	45°C (113°F)
6434H	195 W	64	45°C (113°F)	35°C (95°F)	35°C (95°F)	45°C (113°F)	35°C (95°F)	35°C (95°F)	45°C (113°F)
6448H	250 W	83	40°C (104°F)	35°C (95°F)	35°C (95°F)	40°C (104°F)	35°C (95°F)	35°C (95°F)	40°C (104°F)
8450H	250 W	76	40°C (104°F)	35°C (95°F)	35°C (95°F)	40°C (104°F)	35°C (95°F)	35°C (95°F)	40°C (104°F)
8444H	270 W	72	40°C (104°F)	35°C (95°F)	35°C (95°F)	40°C (104°F)	35°C (95°F)	35°C (95°F)	40°C (104°F)
8454H	270 W	71	40°C (104°F)	35°C (95°F)	35°C (95°F)	40°C (104°F)	35°C (95°F)	35°C (95°F)	40°C (104°F)
8460H	330 W	76	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)
8468H	330 W	77	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)
8490H	350 W	79	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)
	Memory		Ambient temperature						
256 GB RDIMM			35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)
128 GB RDIMM		35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	
64 GB RDIMM			N/A*	N/A*	N/A*	N/A*	N/A*	N/A*	N/A*

Table 48. Thermal restriction matrix for air cooled configurations (continued)

Configuration	32 x 2.5-inch SAS	16 x 2.5- inch SAS + 8 x 2.5-inch NVMe	24 x 2.5- inch NVMe	16 x 2.5- inch SAS	16 x EDSFF E3.S NVMe	8 x 2.5- inch SAS + 16 x EDSFF E3.S NVMe	8 x 2.5- inch SAS
Rear storage	No Rear Drives	No Rear Drives	No Rear Drives	No Rear Drives	No Rear Drives	No Rear Drives	No Rear Drives
32 GB RDIMM	N/A*	N/A*	N/A*	N/A*	N/A*	N/A*	N/A*
16 GB RDIMM	N/A*	N/A*	N/A*	N/A*	N/A*	N/A*	N/A*
GPU			Ambie	ent tempe	erature	·	
Double width (300 W)	N/A	N/A	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)

(i) NOTE: *Memory has the same thermal restrictions of the processor used.

(i) NOTE: Up to six standard (STD) dual fan modules must be installed in all the configurations.

(i) NOTE: GPU air shroud is required, when GPUs are installed in the system.

(i) NOTE: When riser slots four and nine are installed, the supported ambient temperature is 35°C (95°F).

(i) NOTE: DIMM blanks must be installed in empty DIMM slots.

Thermal air restrictions

Table 49. Air cooling configurations thermal restriction for AHSRAE A3 and A4

ASHRAE	A3/40°C (104°F)	A4/45°C (113°F)			
Processor	Processors with a TDP greater than or equal to 330 W are not supported.	Processors with a TDP greater than or equal to 250 W are not supported.			
PSU	Four PSUs are required in redundant mode. If there is PSU failure, system performance may be reduced.				
PCle card	Non-Dell qualified peripheral cards and peripheral cards greater than 25 W are not supported.				
GPU/FPGA	Not supported				
DIMM	128 GB, or greater capacity DIMMs are not supported.				
NVMe storage	2.5-inch NVMe storage is not supported.				
OCP	Supported with 85°C (185°F) active optic cable and cards tier >5 are not supported.				
BOSS	BOSS-N1 is not supported.				
PCIe slot	Slot numbers four and nine are not supported.				

Appendix B. Standards compliance

The system conforms to the following industry standards.

Table 50. Industry standard documents

Standard	URL for information and specifications			
ACPI Advance Configuration and Power Interface Specification, v6.4	https://uefi.org/specsandtesttools			
Ethernet IEEE Std 802.3-2022	https://standards.ieee.org/			
MSFT WHQL Microsoft Windows Hardware Quality Labs	microsoft.com/whdc/system/platform/pcdesign/desguid serverdg.mspx			
IPMI Intelligent Platform Management Interface, v2.0	intel.com/design/servers/ipmi			
DDR5 Memory DDR5 SDRAM Specification	jedec.org/standards-documents/docs/jesd79-4.pdf			
PCI Express PCI Express Base Specification, v5.0	pcisig.com/specifications/pciexpress			
PMBus Power System Management Protocol Specification, v1.2	http://pmbus.org/Assets/PDFS/Public/ PMBus_Specification_Part_I_Rev_1-1_20070205.pdf			
SAS Serial Attached SCSI, 3 (SAS-3) (T10/INCITS 519)	http://www.t10.org/			
SATA Serial ATA Rev. 3.3	sata-io.org			
SMBIOS System Management BIOS Reference Specification, v3.3.0	DMTF SMBIOS			
TPM Trusted Platform Module Specification, v1.2 and v2.0	trustedcomputinggroup.org			
UEFI Unified Extensible Firmware Interface Specification, v2.7	uefi.org/specifications			
PI Platform Initialization Specification, v1.7				
USB Universal Serial Bus v2.0 and SuperSpeed v3.0 (USB 3.1 Gen1)	USB Implementers Forum, Inc. https://usb.org/documents			
NVMe Express Base Specification. Revision 2.0c	https://nvmexpress.org/specifications/			
 NVMe Command Set Specifications NVM Express NVM Command Set Specification. Revision 1.1c NVM Express Zoned Namespaces Command Set. Revision 1.0c NVM Express® Key Value Command Set. Revision 1.0c 				
 NVMe Transport Specifications NVM Express over PCle Transport. Revision 1.0c NVM Express RDMA Transport Revision. 1.0b NVM Express TCP Transport. Revision 1.0c 				
NVMe NVM Express Management Interface. Revision 1.2c				
NVMe NVMe Boot Specification. Revision 1.0				

Appendix C Additional resources

Table 51. Additional resources

Resource	Description of contents	Location	
Installation and Service Manual	This manual, available in PDF format, provides the following information:	Dell.com/Support/Manuals	
	 Chassis features System Setup program System indicator codes System BIOS Remove and replace procedures Diagnostics Jumpers and connectors 		
Getting Started Guide	This guide ships with the system, and is also available in PDF format. This guide provides the following information:Initial setup steps	Dell.com/Support/Manuals	
Rack Installation Guide	This document ships with the rack kits, and provides instructions for installing a server in a rack.	Dell.com/Support/Manuals	
System Information Label	The system information label documents the system board layout and system jumper settings. Text is minimized due to space limitations and translation considerations. The label size is standardized across platforms.	Inside the system chassis cover	
Quick Resource Locator (QRL)	This code on the chassis can be scanned by a phone application to access additional information and resources for the server, including videos, reference materials, service tag information, and Dell contact information.	Inside the system chassis cover	
Enterprise Infrastructure Planning Tool (EIPT)	The Dell online EIPT enables easier and more meaningful estimates to help you determine the most efficient configuration possible. Use EIPT to calculate the power consumption of your hardware, power infrastructure, and storage.	Dell.com/calc	